Overview

HP ProBook 640 G1 Notebook PC



- 1. WLAN antennas (2)*
- 2. WWAN antennas (2)*
- 3. Internal dual-microphone array (2)**
- 4. Webcam light (select models only)
- 5. Webcam (select models only)
- 6. Internal display switch
- 7. Wireless button
- 8. Volume mute button
- 9. Pointing stick (select models only)
- 10. Fingerprint reader (select models only)
- 11. Touchpad buttons
- 12. Touchpad zone

Front/Left

- 13. Pointing stick buttons (select models only)
- 14. Hard drive light
- 15. AC adapter/Battery light
- 16. Power light
- 17. Wireless light
- 18. Smart Card Reader
- 19. Optical Drive (select models only)
- 20. USB 3.0 port (1)
- 21. USB 3.0 Charging port
- 22. RJ-45 (network) jack/lights
- 23. Power connector
- 24. Power button



Overview

* The antennas are not visible from the outside of the computer. For optimal transmission, keep the areas immediately around the antennas free from obstructions.

** Models without optional webcam have single integrated microphone on left side of display panel.



1. Audio-out (headphone) jack/Audio-in (microphone) jack

- 2. USB 3.0 ports (2)
- 3. DisplayPort 1.2

Right

- 4. External VGA monitor port
- 5. Vents (2)
- 6. Security cable slot



Overview



- 1. Service cover
- 2. Battery release latch
- 3. SIM card slot- (inside battery bay)
- 4. Docking connector

HP ProBook 650 G1 Notebook PC

Bottom

- 5. Service cover release lock
- 6. Service door release latch
- 7. Battery bay
- 8. Vents



Overview



- WLAN antennas (2)* 1.
- 2. WWAN antennas (2)*
- Internal dual-microphone array (2)** 3.
- 4. Webcam light (select models only)
- 5. Webcam (select models only)
- 6. Internal display switch
- 7. Wireless button
- 8. Volume mute button
- 9. Pointing stick (select models only)
- Fingerprint reader (select models only) 10.
- **Touchpad buttons** 11.
- 12. Touchpad zone

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- 16. Power light
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- 24. **Power button**

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Overview



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- 2. USB 3.0 ports (2)
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Right

- 4. External VGA monitor port
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Overview



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- 6. Service door release latch
- 7. Battery bay
- 8. Vents



Overview

At A Glance

- Windows 8 versions, Windows 7 versions, SUSE Linux, or FreeDOS 2.0
- New thinner and lighter design ;V PC-ABS (Polycarbonate;VAcrylnitrile/Butadiene/Styrene) durable material is nearly 20% thinner than previous generation; soft-touch, more durable 4-step paint process; larger buttons (power), revamped keyboard (arrow keys); latch/hook removal for clean palmrest design; top mounted speakers for optimized audio experience
- Full-sized spill-resistant keyboard; full separate numeric keypad (HP ProBook 650 only)
- Choice of 4th generation Intel[®] Core. i7, i5 and i3 processors
- Integrated Intel[®] HD Graphics 4600 or AMD Radeon[™] HD 8750M discrete graphics with 1 GB dedicated GDDR5 video memory
- New User Experience Software: HP ePrint, HP Wireless Hotspot (Win 8 only), HP PageLift, HP Trust Circles, HP Mobile Connect (EMEA only)
- Enhanced security features including HP Client Security, new HP Trust Circles and optional HP Fingerprint Reader
- LED-backlit display
 - O HP ProBook 640: 14.0-inch diagonal HD, HD+, FHD
 - HP ProBook 650: 15.6-inch diagonal HD or FHD
- Optional HD webcam with dual-microphone array for video conferencing
- DisplayPort 1.2 now native with integrated graphics
- Four USB 3.0 (640) or Five USB 3.0 (650) ports for fast data transfer from devices (1 charging)
- HD Audio with DTS Studio Sound optimized for high fidelity audio
- Wireless and speaker mute button to conveniently manage the connectivity and speaker.
- Flexible wireless connectivity options:
 - HP Connection Manager allows full control over wireless connections, including 3G and 4G mobile broadband, Wi-Fi, Ethernet and Bluetooth[®] (Win 7 only)
 - O HP Mobile Connect (EMEA Only) (Win 8 Only)
 - O Integrated 4G HP Mobile Broadband Modules
 - Integrated 802.11 b/g/n or a/b/g/n wireless LAN module
 - Integrated 802.11 ac, a/b/g/n or b/g/n with Bluetooth 4.0 combo card (Linux supports Bluetooth 2.1 only) (Bluetooth sold separately or as an optional feature)
 - HP Wireless Hotspot (Win 8 Only)
 - O Intel WiDi Software
- Choice of 7200 rpm user-removable hard drive (up to 500 GB) with HP 3D DriveGuard, 5400 rpm user-removable hard drive (up to 1 TB), 500 GB 7200 rpm Self Encrypting Drive, 500 GB 5400 rpm FIPS Self Encrypting Drive, 256 GB SED Solid State Drive, or 128/180 GB Solid State Drive
- M.2 32GB flash cache for Intel Smart Response Technology

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Features

PRODUCT NAMES

HP ProBook 640 G1 Notebook PC HP ProBook 650 G1 Notebook PC

OPERATING SYSTEM

Preinstalled

Windows 8 64* Windows 8 Pro 64* Windows 7 Professional 32 (available through downgrade rights from Windows 8 Pro 32)** Windows 7 Professional 64 (available through downgrade rights from Windows 8 Pro 64)** Windows 7 Professional 32 Windows 7 Professional 64*** Windows 7 Home Premium 32*** Windows 7 Home Premium 64*** FreeDOS 2.0

* Not all features are available in all editions of Windows 8. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8 functionality. See http://www.microsoft.com for details. ** This system is preinstalled with Windows® 7 Pro software and also comes with a license and media for Windows 8 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

*** Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

PROCESSOR

4th Generation Intel[®] Core[™] i7-4600M with Intel HD Graphics 4600 (2.9 GHz, 4 MB cache, 2 cores)* Up to 3.6 GHz with Intel Turbo Boost Technology

4th Generation Intel[®] Core[™] i5-4330M with Intel HD Graphics 4600 (2.8 GHz, 3 MB cache, 2 cores)* Up to 3.5 GHz with Intel Turbo Boost Technology

4th Generation Intel[®] Core[™] i5-4200M with Intel HD Graphics 4600 (2.5 GHz, 3 MB cache, 2 cores)* Up to 3.1 GHz with Intel Turbo Boost Technology

4th Generation Intel[®] Core[™] i3-4000M with Intel HD Graphics 4600 (2.4 GHz, 3 MB cache, 2 cores)*

* Multi-Core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. 64-bit computing on Intel® architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processors will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. Intel's numbering is not a measurement of higher performance.

NOTE: Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.



Features

INTEL TURBO BOOST TECHNOLOGY*

Intel Turbo Boost is a feature that speeds up the CPU for a short time. It is similar to overclocking the processor, except within a framework provided by Intel. This feature provides additional performance and allows the computer to perform certain tasks more quickly. It also draws additional power and generates additional heat. Therefore, if Turbo Boost is used while powered from battery, it causes additional stress on the battery.

Using Turbo Boost while powered from battery might impact battery cycle life. Cycle life describes how long the battery will last before it needs to be replaced. A cycle refers to one complete charge/discharge cycle of the battery. Because Turbo Boost causes extra stress on the battery, it often shortens the lifetime of the battery.

HP decided not to enable Turbo Boost when powered from battery. This decision was based on the desire to give customers the greatest battery cycle life possible. Turbo Boost is enabled when powered from AC adapter.

Based on customer requests, HP will provide an option to enable Turbo Boost while powered from battery. For the 2013 platform, it will be an F10 option. Turbo Boost will be available for devices powered from battery by the end of the year. The additional performance might cause a slight reduction in battery cycle life, but will not void the battery warranty.

*Implementing Turbo Boost in F10 option is only allowed for batteries over 40WHr.

CHIPSET

Mobile Intel® HM87 or QM87

GRAPHICS

Integrated: Intel® HD* Graphics 4600 Discrete: AMD Radeon™ HD 8750M**, with 1 GB dedicated DDR5 video memory***

* HD content required to view HD images.

*** AMD Dynamic Switchable Graphics technology requires an Intel processor, plus an AMD Radeon™ discrete graphics configuration and is not available on FreeDOS and Linux OS. With AMD Dynamic Switchable Graphics technology, full enablement of all discrete graphics video and display features may not be supported on all systems (e.g. OpenGL applications will run on the integrated GPU or the APU as the case may be).



Features

DISPLAY

HP ProBook 640

Internal

14.0" diagonal LED-backlit HD anti-glare SVA eDP 1.2 flat (1366x768) 14.0" diagonal LED-backlit HD+ anti-glare SVA eDP 1.2 flat (1366x768)

External

Up to 32-bit per pixel color depth

VGA

Port supports resolutions up to 1920 x 1200 external resolution @75 Hz

DisplayPort 1.2

Supports resolutions up to 2560 x 1600, 30-bit color depth at 60 Hz, and full HD (1920 x 1080) monitors, 24-bit color depth at 120 Hz

DVI-D (single link)

Video signal available through DVI port in optional HP Docking Station (sold separately) supports resolutions up to 1600 x 1200 at both full and reduced blanking, and 1920 x 1200 at reduced blanking

NOTE: HD content required to view HD images.

NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.

HP ProBook 650

Internal

15.6" diagonal LED-backlit HD anti-glare SVA eDP 1.2 flat (1366x768)

15.6" diagonal LED-backlit FHD anti-glare SVA eDP 1.2 slim (1920x1080)

External

Up to 32-bit per pixel color depth

VGA

Port supports resolutions up to 1920 x 1200 external resolution @75 Hz

DisplayPort 1.2

Supports resolutions up to 2560 x 1600, 30-bit color depth at 60 Hz, and full HD (1920 x 1080) monitors, 24-bit color depth at 120 Hz

DVI-D (single link)

Video signal available through DVI port in optional HP Docking Station (sold separately) supports resolutions up to 1600 x 1200 at both full and reduced blanking, and 1920 x 1200 at reduced blanking

NOTE: HD content required to view HD images.

NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.



Features

STORAGE AND DRIVES

Primary Storage Bay Hard Drives*

320/500 GB 7200 rpm SMART SATA II HDD 500 GB 7200 rpm SED (Self Encrypting Drive)

Solid State Drive*

128/180 GB 2.5" Solid State Drive 256 GB SED Solid State Drive

HP 3D DriveGuard (Windows only)

The hard drive is mounted directly to the notebook frame, reducing the transmission of shock to the hard drive

For hard drives and solid state drives, GB = 1 billion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows 7) and 36 GB (for Windows 8) of system disk is reserved for the system recovery software. * FIPS-certified, hardware-based AES-256 encryption image

NOTE: For hard drives, GB = 1 billion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows 7) and 36 GB (for Windows 8) of system disk is reserved for the system recovery software.

OPTICAL DRIVES

Fixed 9.5 mm Serial ATA Upgrade Bay DVD+/-RW SuperMulti DL Drive DVD-ROM Drive

Weight saver

FLASH CACHE

32 GB M.2 (NGFF)

Optional 32 GB mSATA flash cache module support for Intel Smart Response Technology. (Available only with standard non-SED hard drive.)



Features

MEMORY

Standard

DDR 3L PC3L-12800 (1600 MHz) Two SODIMM slots supporting dual-channel memory 4 GB and 8 GB SODIMMs **Maximum** Upgradeable to 16384 MB with optional 8192 MB SODIMMs in slots 1 and 2 **Dual-channel** Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory slots.

* Maximum memory capacities assume Windows 64-bit operating systems or Linux. With Windows 32-bit operating systems, memory above 3 GB may not all be available due to system resource requirements.

NOTE: Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

Wireless

Support for a broad range of secure, integrated wireless LAN and wireless WAN options featuring support for the latest industry standards. Broadband Wireless (WWAN) requires a Windows operating system and is available in select countries as a standard, factory configurable feature only. Integrated Bluetooth is also available (factory configurable only) and can be combined with any of the supported wireless LAN and wireless WAN options.

Broadband Wireless (WWAN)

HP hs3110 HSPA+ Mobile Broadband* HP lt4111 LTE/EV-DO/HSPA+ Mobile Broadband Module*,** (US) HP lt4112 LTE/HSPA+ Mobile Broadband Module*,** (EMEA, APJ)

Wireless LAN (WLAN)*

Atheros 802.11b/g/n (1x1)*** Broadcom 802.11a/b/g/n (2x2) and Bluetooth 4.0 Combo***, ***** Intel® Centrino Advanced N-6235 802.11a/b/g/n and Bluetooth 4.0 Combo***, ***** **NOTE:** Supports Bluetooth® v2.1 on Linux operating systems

* WWAN is an optional feature sold separately or as an add on feature. WWAN connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors.

** 4G LTE not available on all products, in all regions and only available on products featuring Intel processors.

Wireless access point and Internet service is required and is not included. Availability of public wireless access points limited. * The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.

***** Bluetooth sold separately or as an optional feature.

Communications

Intel I218LM Gigabit Network Connection*

56K V.92 modem** (available as a factory configurable option)

* The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

** Designed for downloads from 56K modem compliant sources. Maximum achievable download transmission rates currently do



Features

not reach 56 KB/s, and will vary with line conditions. Modem availability is subject to country regulatory approval.

AUDIO/MULTIMEDIA

Audio

HD Audio with DTS Sound+ (2) Integrated stereo speakers Integrated digital microphone (dual-microphone array when equipped with optional webcam)- correct use up Function keys for microphone mute, volume up, volume down Stereo headphone/line out Stereo microphone in

Webcam

Optional* 720p HD** webcam

- HD format (widescreen)
- Supports videoconferencing (non-HD) and still image capture
- High quality fixed focus lens
- Video capture at various resolutions up to 1280x720 resolution (720p) and up to 30fps
- M-JPEG compression supports higher frame rates for video capture and videoconferencing
- Improved low light sensitivity
- Improved dynamic range
- Skype-ready

* Sold separately as an optional feature.

** HD content required to view HD images.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

The HP spill-resistant keyboard is designed using a thin layer of Mylar film under the keyboard. The 101/102-key compatible keyboard features a full-pitch key layout with desktop keyboard features, such as editing keys, both left and right control and alt keys, and function keys. US and International key layouts are available. Includes a separate numeric keypad (HP ProBook 650 only).

Pointing Devices

Touchpad with gestures support, on/off button with LED indicator, two-way scroll, two pick buttons, optional point stick **Buttons and Function Keys**

Separate launch buttons provide easy access to wireless on/off and speaker mute. Function keys provide control of features including: standby mode, display brightness, external display, microphone mute, volume down, and volume up.

SOFTWARE AND SECURITY

Preinstalled Software with Windows Operating System

BIOS

HP DriveLock | HP Automatic Drive Lock HP BIOS Protection* HP Disk Sanitizer** HP SpareKey*** Update via Network Master Record Security



Features

Power On Authentication Pre-Boot Security Secure Erase**** Hybrid Boot Measured Boot Secure Boot Absolute Persistence Module*****

* HP Tools partition with an HP BIOS required for automatic recovery.

** For the use cases outlined in the DOD 5220.22-M Supplement. Does not support Solid State Drives (SSDs). Initial setup required. Web history deleted only in Internet Explorer and Firefox browsers and must be user enabled.

*** Requires initial user set up.

**** For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88.

***** The Absolute Persistence agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: http://www.absolute.com/company/legal/agreements/computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

MultiMedia

CyberLink PowerDVD

Communication

HP Connection Manager (Windows 7 only) HP GPS and Location* HP Mobile Connect** (Windows 8 only) HP Wireless Hotspot*** (Windows 8 only) Intel WiDi Software**** HP Roaming Alert Intel My WiFi and Wireless Drivers

HP Value Add Software

Getting Started with Windows 8 HP 3D DriveGuard HP ePrint Driver***** (HP Exclusive) HP Hotkey Support HP PageLift (HP Exclusive) HP Quick Start HP Recovery Manager (Windows 8 only) HP Support Assistant W8 HP Recovery Disc Creator (Windows 7 only) UEFI System Diagnostics W8

3rd Party

Adobe Flash Player (Commercial) Bing Search Skype***** Buy Office



Features

NOTE: HP Recovery Manager enables fast recovery of the factory preinstalled image if the system becomes corrupted or if important system files are accidentally deleted. Up to 16 GB (for Windows 7) and 36 GB (for Windows 8) of system disk is reserved for the system recovery software.

*GPS access requires an unobstructed path to multiple satellites. Performance may be affected if/when used inside of buildings, bridges or heavily congested metropolitan areas. Requires separately purchased GPS navigation software available from multiple GPS applications.

**Internet access required.

*** The wireless hotspot application requires an active internet connection and separately purchased data plan. While HP wireless hotspot is active, on-device applications will continue to work and will use the same data plan as the wireless hotspot. Wireless hotspot data usage may incur additional charges. Check with your service provider for plan details. Requires Windows.

**** Integrated Intel Wi-Di feature is available on select configurations only and requires separately purchased projector, tv or computer monitor with an integrated or external Wi-Di receiver. External Wi-Di receivers connect to the projector, tv or computer monitor via a standard HDMI cable, also sold separately.

*****Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see www.hp.com/go/eprintcenter).Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary.

****** Skype is not offered in China.

Security

Standard

HP Remote Management of HP Client Security* Security Manager Secure Erase File Sanitizer** HP Trust Circles*** (Planned to be available Fall 2013) TPM 1.2 Embedded Security Chip Integrated Smart Card Reader **HP Spare Key HP** Connection Manager Device Access Manager **Credential Manager** Drive encryption**** Security lock slot Security screw for bottom access door Microsoft Security Essentials***** (Win 7) Computrace Support****** Absolute Data Protect MS Defender (WIN8)

Optional

HP Fingerprint Sensor (plug)

* Not all features are remotely manageable.

** For the use cases outlined in the DOD 5220.22-M Supplement. Does not support Solid State Drives (SSDs). Initial setup required. Web history deleted only in Internet Explorer and Firefox browsers and must be user enabled. *** HP Trust Circles Standard, when included, allows up to 5 Trust Circles with up to 5 contacts in each Trust Circle. Optional Trust Circles Professional required for unrestricted number of Trust Circles and members contacts. Trust Circles Reader is



Features

available to allow a contact to participate in an invited Trust Circle. Requires Windows

***** Requires Windows. Data is protected prior to Drive Encryption login. Turning the PC off or into hibernate logs out of Drive Encryption and prevents data access. Drive encryption planned to be available in October 2013.

***** Opt in and internet connection required for updates.

****** The Absolute Persistence agent is shipped turned off, and is activated with customer purchase of a subscription. Service may be limited. Check with Absolute for availability outside the U.S. The optional subscription service of Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: http://www.absolute.com/company/legal/agreements/computrace-agreement. If Data Delete is utilized, the Recovery Guarantee payment is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either create a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

For more information on HP security solutions refer to: http://www.hp.com/go/security.

POWER

Power Supply

Models with discrete graphics: External 90W HP Smart AC Adapter Models with integrated graphics: External 65W HP Smart AC Adapter External 90W HP Smart AC Adapter Power cord included is 1.8 m (+/- 0.1 m) or 1.0 m (+/- 0.1 m). Total length including external AC adapter is TBD feet (TBD meter). HP Fast Charge*

Primary Battery

HP 9-cell Lithium-Ion Battery (100 WHr) HP 6-cell Lithium-Ion Battery (55 WHr) HP 6-cell Long Life Lithium-Ion Battery (55 WHr) HP 3-cell Lithium-Ion Battery (33 WHr)

Battery Life*

	Configurations with integrated graphics	Configurations with discrete graphics
HP ProBook 640		
6-cell (55 WHr) battery	Up to 13 hours 35 minutes	Up to 13 hours 13 minutes
6-cell Long Life (55 WHr) battery	Up to 11 hours 18 minutes	Up to 11 hours 5 minutes
HP ProBook 650		
6-cell (55 WHr) battery	Up to 13 hours 28 minutes	Up to 13 hours 11 minutes
6-cell Long Life (55 WHr) battery	Up to 11 hours 7 minutes	Up to 10 hours 56 minutes
System Standby Time** Up to TBD days		

* Windows 7 battery life will vary depending on numerous factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.

** Standby life will vary depending on various factors including battery, Memory, CPU, EC and LAN chip. The maximum capacity of



Features

the battery will naturally decrease with time and usage.

NOTE: Fast Charge recharges your battery up to 90% within 90 minutes when the system is off (3- and 6-cell only).

Power Conservation

AMD PowerPlay technology (discrete models) Hibernation Standby ACPI compliance

WEIGHTS & DIMENSIONS

HP ProBook 640 Notebook PC

Weight

Starting at 4.40 lb (2.0 kg) with weight saver (weight will vary by configuration) Starting at 4.69 lb (2.13 kg) with optical drive (weight will vary by configuration) **Dimensions** (w x d x h) $13.39 \times 9.33 \times 0.99$ (front)/1.14 (rear) in $34.0 \times 23.7 \times 2.53$ (front)/2.90 (rear) cm

HP ProBook 650 Notebook PC

Weight

Starting at 5.1 lb (2.32 kg) with weight saver (weight will vary by configuration) Starting at 5.39 lb (2.50 kg) with optical drive (weight will vary by configuration **Dimensions** (w x d x h) $37.80 \times 25.70 \times 2.53$ (front) -2.90 cm (rear)

PORTS/SLOTS

Ports

USB 3.0 – Three (640) USB 3.0 – Four (650) USB 3.0 charging port– One DisplayPort 1.2 – One VGA – One Stereo microphone input – One Headphone/line out – One RJ-45 (Ethernet) – One RJ-11 (Modem)- One (available as a factory configurable option) Docking connector – One RS-232 serial port– One* Power connector – One * ProBook 650 only

Expansion Slots

Media Card Reader - supports SD, SDHC, SDXC



Features

SERVICE AND SUPPORT

HP Services offers limited 3-year and 1-year warranty options depending on country; 1-year limited warranty on primary battery. On-site service and warranty upgrades are also available. Optional* HP Care Pack Services** are extended service contracts which go beyond your standard warranties. For more details visit: http://www.hp.com/go/lookuptool.

*Sold separately or as an optional feature.

** Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. Consult the HP Customer Support Center for details. http://h20000.www2.hp.com/bizsupport/TechSupport/ProductRoot.jsp

NOTE: Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit: www.hp.com/go/cpc



Technical Specifications

SYSTEM UNIT

Requirements (AC Power) Average Operating Power TBD W Max Operating Power Discrete < 90W UMA < 65W or 90W Temperature Operating 32* to 95° F (0* to 35° C) (not writing optical) Non-operating -4* to 140° F (-20* to 60° C) Relative Humidity Operating 5% to 95%, non-condensing Non-operating 5% to 95%, non-condensing Non-operating 200 6, 2 ms, half-sine Shock Operating 200 6, 2 ms, half-sine Non-operating 1.50 grms Non-operating 1.50 grms Non-operating -50 to 10,000 ft (-15.24 to 3,048 m) Non-operating -50 to 40,000 ft (-15.24 to 12,192 m) Planned Industry Stander UL Yes EVEC Compliance Yes EVEC Compliance Yes ICES Yes Australia / Yes Japan VCI Compliance Yes ICES Yes Japan VCI Compliance Yes ICE Marking Compliance Yes ICIT Yes GOST <td< th=""><th>Stand-Alone Power</th><th>Nominal Operating Voltage</th><th>TBD</th></td<>	Stand-Alone Power	Nominal Operating Voltage	TBD
Image: Construct of the second seco	Requirements (AC Power)	Average Operating Power	TBD W
Al* to 95° F (5° to 35° C) (writing optical)Non-operating-4° to 140° F (-20° to 60° C)Relative HumidityOperating10% to 99%, non-condensingNon-operating5% to 95%, 101.6° F (38.7° C) maxinum wet bulb temperatureShockOperating40 G, 2 ms, half-sineNon-operating200 G, 2 ms, half-sineRandom VibrationOperating0.75 grmsNon-operating-50 to 10,000 ft (-15.24 to 3,048 m)Non-operating-50 to 10,000 ft (-15.24 to 3,048 m)Non-operating-50 to 40,000 ft (-15.24 to 12,192 m)Planed Industry StandardULYesCertificationsCSAYesFCC ComplianceYesFERETRegistered TBD in United States**ICESYesAustralia /YesVZA-Tick ComplianceYesKCCYesERERGY STAR®Select models*ICESYesICESYesCeCCYesICEGYesICEGYesICEGYesICEGYesICEM arking ComplianceYesICEM arking ComplianceYes <trr>ICEM arking Compliance<td< th=""><th></th><th>Max Operating Power</th><th></th></td<></trr>		Max Operating Power	
Relative Humidity Operating 10% to 90%, non-condensing Non-operating 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature Shock Operating 40 G, 2 ms, half-sine Random Vibration Operating 200 G, 2 ms, half-sine Random Vibration Operating 0.075 grms Attitude (unpressurize) Operating -50 to 10,000 ft (-15.24 to 3,048 m) Non-operating -50 to 40,000 ft (-15.24 to 3,048 m) Non-operating -50 to 40,000 ft (-15.24 to 3,048 m) Non-operating -50 to 40,000 ft (-15.24 to 12,192 m) Planned Industry Standard UL Yes Certifications CSA Yes FCC Compliance Yes Yes EPEAT Registered TBD in United States** ICES NZ A-Tick Compliance Yes Yes IZE A-Tick Compliance Yes IZE A-Tick Compliance KC Yes Yes IZE A-Tick Compliance Yes IZE A-Tick Compliance KC Yes IZE A-Tick Compliance Yes IZE A-Tick Compliance Yes	Temperature	Operating	
Non-operation%0 5% 5% 5% 5% 5%Non-operation0.6 2 ms, Nalf-SineNon-operation0.6 2 ms, Nalf-SineNon-operation0.7 5 grmsAttude (unpressure)0.6 10 000 ft (15.24 to 3,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 3,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 3,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 13,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 13,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 13,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 13,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 13,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 13,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 13,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 13,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 13,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 13,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 13,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 13,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 13,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 13,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 13,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 13,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 13,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 13,048 mt)Paned Industry Stam0.6 10 000 ft (15.24 to 13,048 mt)Paned Industry Stam0.6 10 000 ft (15.24		Non-operating	-4° to 140° F (-20° to 60° C)
ShockOperating40.6.2 ms.half-sineNon-operating200.6.2 ms.half-sineRandom VibrationOperating0.75 grmsNon-operating1.50 grmsAltitude (unpressurize)Operating-50 to 10.000 ft (-15.24 to 3.048 m)Planned Industry StandarULVesCertificationsCSAVesECC ComplianceVesFERATRegistered TBD in United States**ICESVesNZ A-Trick ComplianceVesVZ A-Trick ComplianceVesVZ A-Trick ComplianceVesVZ A-Trick ComplianceVesVZ A-Trick ComplianceVesVEGCU ComplianceVesVEGENVesVEGENVesVEGENVesVEGENVesVEGENVesVEGENVesVEGENVesVEGENVesVEGENVesVEGENVesVEGENVesVERATING ComplianceVesVERATING ComplianceVes<	Relative Humidity	Operating	10% to 90%, non-condensing
Non-operating200 G, 2 ms, half-sineRandom VibrationOperating0.75 grmsNon-operating1.50 grmsAltitude (unpressurized)Operating-50 to 10,000 ft (-15.24 to 3,048 m)Non-operating-50 to 40,000 ft (-15.24 to 12,192 m)Planned Industry StandardULYesCertificationsCSAYesFCC ComplianceYesFCC ComplianceSelect models*FDEATRegistered TBD in United States**ICESVesAustralia /YesNZ A-Tick ComplianceYesICESVesAustralia /YesICESVesJapan VCCI ComplianceYesICENYesICENYesICENYesICENYesICENYesICENYesICENYesICENYesICENYesICEN BINIYesICITYesICITYesSaudi Arabian ComplianceYesICENYesSaudi Arabian ComplianceYesSaudi Arabian ComplianceYesYesYesYesYesYesYesYes <t< th=""><th></th><th>Non-operating</th><th>5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature</th></t<>		Non-operating	5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature
Random VibrationOperating0.75 grmsNon-operating1.50 grmsAltitude (unpressurized)Operating-50 to 10,000 ft (-15.24 to 3,048 m)Non-operating-50 to 40,000 ft (-15.24 to 12,192 m)Planned Industry StandardULYesCertificationsCSAYesFCC ComplianceYesFDEATRegistered TBD in United States**ICESYesAustralia /YesNZ A-Tick ComplianceYesIQUAAustralia /NZ A-Tick ComplianceYesIQUAYesIQUAYesIQUAAustralia /NZ A-Tick ComplianceYesIQUAYes <td< th=""><th>Shock</th><th>Operating</th><th>40 G, 2 ms, half-sine</th></td<>	Shock	Operating	40 G, 2 ms, half-sine
Non-operating1.50 grmsAltitude (unpressurize)Operating-50 to 10,000 ft (-15.24 to 3,048 m)Non-operating-50 to 40,000 ft (-15.24 to 12,192 m)Planned Industry Standard CertificationsULYesCSAYesFCC ComplianceYesENERGY STAR®Select models*EPEATRegistered TBD in United States**ICESYesAustralia / NZ A-Tick ComplianceYesZCCYesICESYesICE Marking ComplianceYesICE OSTYesICESYesICESYesICESYesICESYesICESYesICESYesICESYesICESYesICESYesICESYesICESYesICESYesICESYesICES </th <th></th> <th>Non-operating</th> <th>200 G, 2 ms, half-sine</th>		Non-operating	200 G, 2 ms, half-sine
Attitude (unpressurized)Operating-50 to 10,000 ft (-15.24 to 3,048 m)Non-operating-50 to 40,000 ft (-15.24 to 12,192 m)Planned Industry StandardULYesCertificationsULYesFCC ComplianceYesENERGY STAR®Select models*EPEATRegistered TBD in United States**ICESYesAustralia / NZ A-Tick ComplianceYesICESYesICESYesJapan VCCI ComplianceYesISMIYesBSMIYesICTYesICTYesICTYesICTYesICTYesSaudi Arabian ComplianceYesICT	Random Vibration	Operating	0.75 grms
Paned Industry StandNon-operating-50 to 40,000 ft (-15.24 to 12,192 m)Paned Industry StandVSCSAVSFCC OmplianceVSENERGY STAR*Rejsterd TBD in United States**ICESVSAustralia / N2 + Trick ComplianceVSICC0VS		Non-operating	1.50 grms
Planned Industry StandardULYesCertificationsCSAYesCSCFCC ComplianceYesFDEATRegistered TBD in United States**ICESYesAustralia /YesNZ A-Tick ComplianceYesICCCYesJapan VCCI ComplianceYesKCYesBSMIYesCEC marking ComplianceYesICT methodYesICT methodYesICT methodYesSMIYesICT methodYesICTYesICTYesICTYesICTYesSadi Arabian ComplianceYesICTYesSABSYesICTYes <th>Altitude (unpressurized)</th> <th>Operating</th> <th>-50 to 10,000 ft (-15.24 to 3,048 m)</th>	Altitude (unpressurized)	Operating	-50 to 10,000 ft (-15.24 to 3,048 m)
CertificationsCSAYesFCC complianceYesFCRGY STAR®Select models*EPEATRegistered TBD in United States**ICESYesAustralia /YesNZ A-Tick ComplianceYesICCQYesJapan VCCI ComplianceYesKCYesEBMIYesCEC Marking ComplianceYesICTYes		Non-operating	-50 to 40,000 ft (-15.24 to 12,192 m)
FCC ComplianceYesFCC ComplianceSelect models*ENERGY STAR®Select models*EPEATRegistered TBD in United States**ICESYesAustralia /YesNZ A-Tick ComplianceYesCCCYesJapan VCCI ComplianceYesKCYesBSMIYesCE Marking ComplianceYesCITYesGOSTYesGOSTYesSABSYesVRRSERTCOMPUTERYes		UL	Yes
ENERGY STAR®Select models*EPEATRegistered TBD in United States**ICESYesAustralia / NZ A-Tick ComplianceYesCCCYesJapan VCCI ComplianceYesKCYesEBSMIYesCE Marking ComplianceYesICT OBLUSYesGOSTYesGaudi Arabian ComplianceYesSABSYesKRSERTCOMPUTERYes <th>Certifications</th> <th>CSA</th> <th>Yes</th>	Certifications	CSA	Yes
EPEATRegistered TBD in United States**ICESYesAustralia / NZ A-Tick ComplianceYesICCVesJapan VCCI ComplianceYesKCYesBSMIYesCE Marking ComplianceYesIDC on BELUSYesICTYesGOSTYesGAIA Arabian ComplianceYesSABSYesKCYesKIYes <trt< th=""><th></th><th>FCC Compliance</th><th>Yes</th></trt<>		FCC Compliance	Yes
ICESYesAustralia / NZ A-Tick ComplianceYesICCYesJapan VCCI ComplianceYesKCYesBSMIYesCE Marking ComplianceYesIDT or BELUSYesIDT or BELUSYesGOSTYesGoSTYesSABSYesIDKRSERTCOMPUTERYes		ENERGY STAR®	Select models*
Australia / NZ A-Tick ComplianceYesCCCYesJapan VCCI ComplianceYesKCYesBSMIYesCE Marking ComplianceYesBNCI or BELUSYesCITYesGOSTYesSaudi Arabian ComplianceYesSABSYesUKRSERTCOMPUTERYes		EPEAT	Registered TBD in United States**
NZ A-Tick ComplianceCCCYesJapan VCCI ComplianceYesKCYesBSMIYesCE Marking ComplianceYesDICI or BELUSYesCITYesGOSTYesSaudi Arabian ComplianceYesSABSYesUKRSERTCOMPUTERYes		ICES	Yes
Japan VCCI Compliance Yes KC Yes BSMI Yes CE Marking Compliance Yes BNCI or BELUS Yes CIT Yes GOST Yes Saudi Arabian Compliance Yes SABS Yes UKRSERTCOMPUTER Yes			Yes
KCYesBSMIYesCE Marking ComplianceYesBNCI or BELUSYesCITYesGOSTYesSaudi Arabian ComplianceYesSABSYesUKRSERTCOMPUTERYes		CCC	Yes
BSMIYesCE Marking ComplianceYesBNCI or BELUSYesCITYesGOSTYesSaudi Arabian ComplianceYesSABSYesUKRSERTCOMPUTERYes		Japan VCCI Compliance	Yes
CE Marking ComplianceYesBNCI or BELUSYesCITYesGOSTYesSaudi Arabian Compliance (ICCP)YesSABSYesUKRSERTCOMPUTERYes		КС	Yes
BNCI or BELUSYesCITYesGOSTYesSaudi Arabian ComplianceYesICCPYesSABSYesUKRSERTCOMPUTERYes		BSMI	Yes
CITYesGOSTYesSaudi Arabian Compliance (ICCP)YesSABSYesUKRSERTCOMPUTERYes		CE Marking Compliance	Yes
GOST Yes Saudi Arabian Compliance Yes (ICCP) SABS Yes UKRSERTCOMPUTER Yes		BNCI or BELUS	Yes
Saudi Arabian Compliance Yes (ICCP) SABS Yes UKRSERTCOMPUTER Yes		CIT	Yes
(ICCP) SABS Yes UKRSERTCOMPUTER Yes		GOST	Yes
UKRSERTCOMPUTER Yes			Yes
		SABS	Yes

* Configurations of the HP ProBook 640 and HP ProBook 650 that are ENERGY STAR qualified are identified as HP ProBook 640 ENERGY STAR and HP ProBook 650 ENERGY STAR on HP websites and on www.energystar.gov.

** EPEAT registration varies by country. See <u>www.epeat.net</u> for registration status by country. EPEAT status listed above applies to U.S.

For accessibility information on HP products, please visit: http://www.hp.com/accessibility.



Technical Specifications

DISPLAYS

14" diagonal LED-backlit HD anti-glare SVA flat	Outline Dimensions (W x H x D)	12.6 x 8.09 x 0.14 in (32.09 x 20.56 x 0.36 cm)		
(1366 x 768)	Active Area	12.18 x 6.85 in (30.94 x 17.395 cm)		
	Weight	0.71 lb (320g) (max)		
	Diagonal Size	14.0 in (35.6cm)		
	Surface Treatment	Anti-glare		
	Contrast Ratio	300:1 (min)		
	Refresh Rate	60 Hz		
	Brightness	200 nit (typical)		
	Pixel Resolution	Format	1366 x 768 (HD)	
		Configuration	RGB Stripe	
	Interface	eDP 1.2 (1 lane)		
	LCD Mode	TN		
	PPI	125 ppi		
	Viewing Angle	SVA 40/40/15/30 (Left/Right/Down/Up)		
14" diagonal LED-backlit	Outline Dimensions	12.6 x 8.09 x 0.14 in (32.09	2.09 x 20.56 x 0.36 cm)	
HD+ anti-glare SVA flat	(W x H x D)			
(1600 x 900)	Active Area	12.19 x 6.86 in (30.96 x 17.415 cm)		
	Weight	0.72 lb (325 g) (max)		
	Diagonal Size	14.0 in (35.6cm)		
	Surface Treatment	Anti-glare		
	Contrast Ratio	300:1 (min)		
	Refresh Rate	60 Hz		
	Brightness	250 nit (typical)		
	Pixel Resolution	Format	1600 x 900 (HD+)	
		Configuration	RGB Stripe	
	Interface	eDP 1.2 (1 lane)		
		TAL		
	LCD Mode	TN		
	LCD Mode PPI Viewing Angle	1N 131 ppi SVA 40/40/15/30 (Left/Rig		



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14" diagonal LED-backlit FHD anti-glare UWVA slim		12.6 x 8.09 x 0.12 in (32.09 x 20.56 x 0.3 cm)	
(1920 x 1080)	Active Area	12.18 x 6.85 in (30.93 x 17.4 cm)	
	Weight	0.75 lb (340 g) (max)	
	Diagonal Size	14.0 in (35.6cm)	
	Surface Treatment	Anti-glare	
	Contrast Ratio	600:1 (min)	
	Refresh Rate	60 Hz	
	Brightness	300 nit (typical)	
	Pixel Resolution	Format	1920 x 1080 (FHD)
		Configuration	RGB Stripe
	Interface	eDP 1.3+PSR (2 lane)	
	LCD Mode	IPS/FFS/VA	
	PPI	157 ррі	
	Viewing Angle	UWVA 85/85/85/85 (Left/R	light/Down/Up)
15.6" diagonal LEDbacklit		14.17 x 8.83 x 0.15 in (36.0	x 22.43 x 0.38 cm)
HD anti-glare SVA	(W x H x D)		
flat (1366 x 768)	Active Area	13.55 x 7.62 in (34.42 x 19.	.35 cm)
	Weight	< 1.1 lb (500 g) (max)	
	Diagonal Size	15.6 in (39.62 cm)	
	Surface Treatment	Anti-glare	
	Contrast Ratio	300:1 (min)	
	Refresh Rate	60 Hz	
	Brightness	200 nit (typical)	
	Pixel Resolution	Format	1366 x 768 (HD)
		Configuration	RGB Stripe
	Interface	eDP 1.2 (1 lane)	
	LCD Mode	TN	
		101 ppi	
	PPI		
	PPI Viewing Angle	101 ppi SVA 40/40/15/30 (Left/Rig	ht/Down/Up)



Technical Specifications

15.6" diagonal LEDbacklit FHD anti-glare	Outline Dimensions (W x H x D)	TBD	
SVA slim (1920 x 1080)	Active Area	TBD	
	Weight	TBD	
	Diagonal Size	TBD	
	Surface Treatment	TBD	
	Contrast Ratio	TBD	
	Refresh Rate	TBD	
	Brightness	TBD	
	Pixel Resolution	Format	1920 x 1080 (FHD)
		Configuration	RGB Stripe
	Interface	eDP 1.2 (2 lane)	
	LCD Mode	TN	
	PPI	TBD	
	Viewing Angle	UWVA 85/85/85/85 (Left/F	Right/Down/Up)

STORAGE AND DRIVES

Internal Storage			
320 GB* 5400 rpm SATA	Drive Weight	0.25 lbs (115 g)	
Hard Drive	Capacity	320 GB	
	Height	0.37 in (9.5 mm)	
	Width	2.75 in (70 mm)	
	Interface	ATA-8, SATA 2.6, 3.0 Gb/s, NCQ	
	Transfer Rate	Synchronous (maximum)	300 MB/s (Drive Capability)
	Seek Time (typical reads, including settling)	Single Track	1.5 ms
		Average	11 ms
		Maximum	22 ms
	Rotational Speed	7200 rpm	
	Logical Blocks	625,142,448	
	Operating Temperature	32° to 140° F (0° to 60° C) [case temp]
	Features	ATA Security	



500 GB* 5400 rpm SATA	Drive Weight	0.22 lb (101 g)	
Hard Drive	-	-	
	Capacity	500 GB	
	Height	0.37 in (9.5 mm)	
	Width	2.75 in (70 mm)	
	Interface	ATA-8, SATA 2.6, 3.0 Gb/s,	NCQ
	Transfer Rate	Synchronous (maximum)	300 MB/s (Drive Capability)
	Seek Time	Single Track	3 ms
	(typical reads, including	Average	13 ms
	settling)	Maximum	24 ms
	Rotational Speed	5400 rpm	
	Logical Blocks	976,773,168	
	Operating Temperature	32° to 140° F (0° to 60° C) [case temp]
	Features	ATA Security	
1 TB* 5400 rom	Drive Weight	0.254 lb (115 g)	
1 TB* 5400 rpm SATA Hard Drive	-	-	
SATA Hard Brive	Capacity	1 TB	
	Height	0.37 in (9.5 mm)	
	Width	2.75 in (70 mm)	
	Interface	ATA-8, SATA 2.6, 3.0 Gb/s, NCQ	
	Transfer Rate	Synchronous (maximum)	300 MB/s (Drive Capability)
	Seek Time	Single Track	3 ms
	(typical reads, including	Average	13 ms
	settling)	Maximum	24 ms
	Rotational Speed	5400 rpm	
	Logical Blocks	1,953,525,168	
	Operating Temperature	32° to 140° F (0° to 60° C) [case temp]
	Features	ATA Security	



320 GB* 7200 rpm SATA Hard Drive	Drive Weight Capacity	0.25 lbs (115 g) 320 GB	
	Height	0.37 in (9.5 mm)	
	Width	2.75 in (70 mm)	
	Interface	ATA-8, SATA 2.6, 3.0 Gb/s,	NCQ
	Transfer Rate	Synchronous (maximum)	300 MB/s (Drive Capability)
	Seek Time	Single Track	1.5 ms
	(typical reads, including	Average	11 ms
	settling)	Maximum	22 ms
	Cache	16 MB	
	Rotational Speed	7200 rpm	
	Logical Blocks	625,142,448	
	Operating Temperature	32° to 140° F (0° to 60° C) [case temp]
	Features	ATA Security	
500 GB* 7200 rpm SATA	Drive Weight	0.25 lbs (115g)	
Hard Drive	Capacity	500 GB	
	Height	0.37 in (9.5 mm)	
	Width	2.75 in (70 mm)	
	Interface	ATA-8, SATA 2.6, 3.0 Gb/s,	NCQ
	Transfer Rate	Synchronous (maximum)	300 MB/s (Drive Capability)
	Seek Time	Single Track	1.5 ms
	(typical reads, including	Average	11 ms
	settling)	Maximum	22 ms
	Rotational Speed	7200 rpm	
	Logical Blocks	976,773,168	
	Operating Temperature	32° to 140° F (0° to 60° C) [case temp]
	Features	ATA Security	
		,	



750 GB* 7200 rpm SATA Hard Drive	Drive Weight Capacity Height Width Interface Transfer Rate Seek Time (typical reads, including settling) Rotational Speed Logical Blocks	0.25 lbs (115g) 750 GB 0.37 in (9.5 mm) 2.50 in (63.5 mm) ATA-8, SATA 2.6, 3.0 Gb/s Synchronous (maximum) Single Track Average Maximum 7200 rpm 1,465,149,168	300 MB/s (Drive Capability) 1.5 ms 11 ms 22 ms
	Operating Temperature	32° to 140° F (0° to 60° C) [case temp]
	Features	ATA Security	
500 GB* 7200 rpm SMART SATA II Self Encrypting Drive	Drive Weight Capacity Height Width Interface Transfer Rate	0.25 lbs (115g) 500 GB 0.37 in (9.5 mm) 2.50 in (63.5 mm) ATA-8, SATA 2.6, 3.0 Gb/s Synchronous (maximum)	300 MB/s (Drive Capability)
	Seek Time	Single Track	1 ms
	(typical reads, including settling)	Average Maximum	12 ms 20 ms
	Cache	16 MB	201115
	Rotational Speed	7200 rpm	
	Logical Blocks	976,773,168	
	Operating Temperature	32° to 140° F (0° to 60° C) [case temp]
	Features	ATA Security	



500 GB* 5400 rpm SATA	Drive Weight	0.25 lbs (95g)	
FIPS** Hard Drive	Capacity	500 GB	
	Height	0.28 in (7 mm)	
	Width	2.75 in (70 mm)	
	Interface	ATA-8, SATA 2.6, 3.0 Gb/s,	NCQ
	Transfer Rate		300 MB/s (Drive Capability)
	Seek Time	Single Track	1.5 ms
	(typical reads, including	Average	11 ms
	settling)	Maximum	22 ms
	Cache	16 MB	
	Rotational Speed	5400 rpm	
	Logical Blocks	976,773,168	
	Operating Temperature	32° to 140° F (0° to 60° C) [case temp]
	Features	ATA Security	
SATA 6 Gb/s 128 GB*, 2.5-	Drive Weight	73 Grams 128 GB 0.276 in (7 mm) 2.76 in (70 mm)	
inch Solid State Drive	Capacity		
	Height		
	Width		
	Interface	SATA 3 (6 Gb/s)	
	Performance	Maximum Sequential Read	d Maximum Sequential Write
		415 MB/s	175 MB/s
	Logical Blocks	250,069,680	
	Operating Temperature	32° to 158°F (0° to 70°C) [ca	•
	Features	ATA Security; ATA-8; SATA	3.0; DIPM; TRIM
1			
SATA 6 Gb/s 180 GB*, 2.5-	-	78 Grams	
inch SATA Solid State Drive	Capacity	180 GB	
	Height	0.276 in (7 mm)	
	Width	2.76 in (70 mm)	
	Interface	SATA Gen 3 (6 Gb/s)	
	Performance	Maximum Sequential Read	-
		Up to 550 MB/s	Up to 520 MB/s
	Logical Blocks	351,651,888	
	Operating Temperature	32° to 158°F (0° to 70°C) [ca	
	Features	ATA Security; ATA-8, SATA	טורייו, ואוייו



Technical Specifications

SATA 6 Gb/s 256 GB*, 2.5-		73 Grams	
inch SATA SED Solid State	Capacity	256 GB	
Drive	Height	0.276 in (7 mm)	
	Width	2.76 in (70 mm)	
	Interface	SATA 3 (6 Gb/s)	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		Up to 460 MB/s	Up to 260 MB/s
	Logical Blocks	500,118,192	
	Operating Temperature	32° to 158°F (0° to 70°C) [case temp]	
	Features	ATA Security; ATA-8 compliant; SATA 3	.0; DIPM; TRIM

* For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows 7) and 36 GB (for Windows 8) of system disk is reserved for the system recovery software. ** * FIPS-certified, hardware-based AES-256 encryption image.

OPTICAL DRIVES

DVD+/-RW SuperMulti DL Drive	Access Times	Random	<140ms CD (typical) < 160 ms DVD (typical)
	Max Data Transfer Rate	24X CD-ROM 8X DVD 24X CD-R 24X CD-RW 8X DVD+R 8X DVD+RW 8X DVD-R 6X DVD-RW 6X - DVD-RW 6X - DVD+R Dual Layer 6X - DVD-R Dual Layer 5X DVD-RAM	
	Transfer Mode	UDMA Mode 5	
	Interface	Gen 1 SATA	
	Supported Media (read)	(Photo-CD, Video CD), Mult	CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge isession CD (Photo-CD, CD-EXTRA, Portfolio, CD-R,)-ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R, , DVD-RAM
	Supported Media (write)	CD-R, CD-RW, DVD+R, DVD DL	+RW, DVD-R, DVD-RW, DVD-RAM, DVD+R DL, DVD-R
	Max Media Capacity (read)	8.5 GB	
	Max Media Capacity (write)	8.5 GB	
	Transport	Tray Loading	



Technical Specifications

DVD-ROM Drive	Access Times	Random	< 140 ms CD (typical) < 160 ms DVD (typical)
	Max Data Transfer Rate	24X CD-ROM 8X-DVD	
	Transfer Mode	UDMA Mode 5	
	Interface	Gen 1 SATA	
	Supported Media (read)	(Photo-CD, Video CD), Mult	CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge tisession CD (Photo-CD, CD-EXTRA, Portfolio, CD-R, D-ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R, /, DVD-RAM
	Supported Media (write)	None	
	Max Media Capacity (read)	8.5GB	
	Transport	Tray Loading	

SECURITY

HP Fingerprint Reader	Mobile Voltage Operation	3.0V-3.6V
(optional)	Operating Temperature	14° - 167°F (-10° - 75°C)
	Current Consumption Image	36 mA peak
	Low Latency Wait for Finger	950 uA
	Capture Rate	3000. lines/sec
	ESD Resistance	IEC 61000-4-2 4B (±15KV)
	Detection Matrix	200*1 (plus another secondary line) 508 dpi 12*3 mm sensor area

NETWORKING/COMMUNICATIONS



Intel I218LM Gigabit	Connector	RJ-45
Network Connection	System Interface	Integrated on PCA
	Controller	Intel I218LM GbE platform LAN connect networking controller
	Memory	24 KB FIFO packet buffer memory
	Data rates supported	10/100/1000 Mbps
	IEEE Compliance	802.1P 802.1Q 802.2 802.3 802.3ab 802.3az 802.3az
	Bus architecture	PCI Express and SMBus
	Data transfer mode	PCIe-based interface for active state operation (S0 state) and SMBus for host and management traffic (Sx low power state)
	Power requirement	Requires 3.3V and 0.9V or just 3.3V with integrated regulators Power consumption 0.733 Watts
	Boot ROM support	Yes
	Network transfer mode	Full-duplex
		Half-duplex (not supported for the 1000BASE-T transceiver)
	Network transfer rate	10BASE-T (half-duplex) 10 Mbps
		10BASE-T (full-duplex) 20 Mbps
		100BASE-TX (half-duplex) 100 Mbps
		100BASE-TX (full-duplex) 200 Mbps
		1000BASE-T (full-duplex) 2000 Mbps
	Environmental	Operating Temperature: 0° to 85° C
		Operating Humidity: 60% RH
	Management	WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable diagnostic.
	Alerting	ASF 2.0 support; iAMT 9.0 support
HP 3110 HSPA+ Mobile Broadband Module*	Technology/Operating Bands	CDMA/1xRTT/EvDO: 800MHz (Cell), 1900MHz (PCS) GSM/GPRS/EDGE: 850MHz (Cell), 900MHz (EGSM), 1800MHz (DCS), 1900MHz (PCS) UMTS/WCDMA with receive diversity: 2100MHz (UTRA FDD Band I), 1900MHz (UTRA FDD Band II), 900MHz (UTRA FDD Band VIII), 850 MHz (UTRA FDD Band V) LTE: 700 MHz (Verizon, Band XIII)
	Mobile Operator	Verizon (US only)
	Wireless Protocol Standards	GSM/GPRS/EDGE: Class B, Multi-slot class 10 operation, coding schemes CS1 - CS4 and MSC1 - MSC9. CDMA: 1xEVD0 Release 0 and Release A, IS-95A, IS-95B, IS-856, IS-2000 UMTS/WCDMA: Release 99 and Release 7 LTE: Power Class III as per 3GPP TS 36.101



Technical Specifications

	Wireless Parametric Standards	Complies with 3GPP specifications Release 8 for LTE
	Maximum Data Rates	EvDO (Revision A) - 3.1 Mbps (Download), 1.8 Mbps (Upload) WCDMA (DC-HSPA+) - 42Mbps (Download) LTE (Category 3) - 100 Mbps (Download), 50Mbps (Upload)
	GPS	Standalone, Assisted, XTRA
	GPS Bands	1575.42 MHz (± 1.023 MHz)
	Maximum Output Power	GSM/GPRS/EDGE: 32dBm (+/-1) WCDMA: 24dBm (+0.7/-2.3) LTE: +23 dBm (+2.7 dBm/-1.7 dBm) 1xRTT/EvD0: +24 dBm (+0.5 dBm/-1.5 dBm)
	Maximum Power Consumption	2700mA (peak)
	Power Consumption, Sleep Mode	10 mA
	Power Management	USB selective suspend Integrated notebook wireless button
	Antenna Type	Dual high efficiency 6 band antennae with spatial diversity, mounted in the display enclosure
	Form Factor	PCI-Express MiniCard, USB 2.0 interface
	Weight	< 10 g
	Dimensions (Length x Width x Thickness)	2.01 x 1.18 x 0.18 in (51 x 30 x 4.5 mm)
	Voltage, Operating	3.3v +/- 9%
	Temperature, Operating	-4° to 149° F (-20° to 65° C)
	Temperature, Non- operating, 96 hours (from MIL-STD 202 Method 108)	-40° to 185° F (-40° to 85° C)
	Humidity, Non-operating	85% relative humidity for 48 hours @ 185° F (85° C) (non-condensing)
	LED Activity	LED Off - Radio Off; Solid LED On - Radio On
	wireless data service contra	otional feature sold separately or as an add on feature. Connection requires act, network support, and is not available in all areas. Contact service provider area and availability. Connection speeds will vary due to location, environment, her factors.
*	Technology/Operating Bands	LTE FDD all bands with diversity: 1900 MHz (Band II) ¹ , 1700/2100MHz (Band IV (AWS) 850 MHz (Band V) 700MHz (Band XIII) 700MHZ (Band XVII) 1900MHz G

HP lt4111 LTE/EV- Techno D0/HSPA+ 4G WWAN* Bands LTE FDD all bands with diversity: 1900 MHz (Band II)¹, 1700/2100MHz (Band IV (AWS), 850 MHz (Band V), 700MHz (Band XIII), 700MHZ (Band XVII), 1900MHz G Block (Band XXV)
 WCDMA/HSDPA/HSUPA/HSPA+: all bands with diversity: 2100 MHz (Band I), 1900 MHz (Band II), AWS 1700/2100MHz (Band IV), 850 MHz (Band V), 800 MHz (Band VIII)
 GSM/GPRS/EDGE: 1900 MHz, 1800 MHz , 850 MHz , 900 MHz (CDMA: Cellular 800MHz (BC0), PCS 1900MHz (BC1)



Technical Specifications

Wireless Protocol Standards	3GPP Release 8 LTE Specification WCDMA R99, 3GPP Release 5, 6 and 7 UMTS Specification EVDO Release 0 and Release A
Wireless Parametric Standards	Complies with 3GPP specifications Release 8 for LTE
Maximum Data Rates	LTE (Category 3): 100 Mbps (Download), 50Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21.6 Mbps (Download), 5.76 Mbps (Upload) EDGE: 236.8 kbps (Download), 236.8 kbps (Upload) GPRS: 85.6 kbps(Download), 85.6 kbps (Upload)
GPS	Standalone GPS, A-GPS, GPS XTRA
GPS Bands	1575.42 MHz (± 1.023 MHz), GLONASS 1596-1607MHz
Maximum Output Power	LTE: +23 dBm (+/- 1 dBm) WCDMA: +23 dBm (+/- 1 dBm) GSM850/900, GMSK: +32dBm (+/- 1dBm) GSM850/900, 8PSK: +27dBm (+/- 1dBm) DCS1800 / PCS 1900, GMSK: +29dBm (+/- 1dBm) DCS1800 / PCS 1900, 8PSK: +26dBm (+/- 1dBm) CDMA: +24dBm (+/- 1dBm)
Maximum Power Consumption	LTE: 1,200 mA (peak); <900 mA (average) WCDMA: 1,100 mA (peak); <800 mA (average) EGPRS: 2,500 mA (peak); <700 mA (average)
Power Consumption, Sleep Mode	2 mA
Power Management	USB selective suspend, Integrated notebook wireless button
Antenna Type	Dual high efficiency multi-band antennae with spatial diversity
Form Factor	M.2, 3042-S3 Key B
Weight	6 g
Dimensions (Length x Width x Thickness)	42 mm × 30 mm × 2.3 mm
Voltage, Operating	3.135 V to 4.4 V (3.3 V +1.1V/-0.165V)
Temperature, operating (from TIA/EIA/IS-98-D)	-13° to 140° F (-25° to 60° C)
Temperature, non- operating, 96 hours (from MIL-STD 202 Method 108)	-40° to 185° F (-40° to 85° C)
Humidity, Non-operating	95% relative humidity for 48 hours @ 185° F (85° C) (non-condensing)
LED Activity	LED Off - Radio Off; Solid LED On - Radio On
firmware update.	50 MHz (Band V) not supported at launch but support planned in a future

* 4G LTE not available on all products, in all regions and only available on products featuring Intel processors. WWAN use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors.



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Technical Specifica	tions	
HP lt4112 LTE/HSPA+ Gobi 4G Module*	Technology/Operating Bands	LTE FDD all bands with diversity: 2100 MHz (Band I), 1900 MHz (Band II), 1800 MHz (Band III), 850 MHz (Band V), 2600 MHz (Band VII), 900 MHz (Band VIII), 800 MHz (Band XX, DD800) WCDMA/HSDPA/HSUPA/HSPA+ all bands with diversity: 2100 MHz (Band I), 1900 MHz (Band II), 800 MHz (Band V), 900 MHz (Band VIII) GSM/GPRS/EDGE: 1900 MHz (Band II), 1800 MHz (Band III), 850 MHz (Band V), 900 MHz (Band VIII)
	Wireless Protocol Standards	3GPP Release 8 LTE Specification WCDMA R99, 3GPP Release 5, 6 and 7 UMTS Specification
	Wireless Parametric Standards	Complies with 3GPP specifications Release 8 for LTE
	Maximum Data Rates	LTE (Category 3): 100 Mbps (Download), 50Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21.6 Mbps (Download), 5.76 Mbps (Upload) EDGE: 236.8 kbps (Download), 236.8 kbps (Upload) GPRS: 85.6 kbps(Download), 85.6 kbps (Upload)
	GPS	Standalone
	GPS Bands	1575.42 MHz (± 1.023 MHz), GLONASS 1596-1607MHz
	Maximum Output Power	LTE: +23 dBm (+/- 2 dBm) WCDMA: +23.5 dBm (+/- 1 dBm) GPRS Band II, III: +29.5 dBm (+/- 1 dBm) GPRS Band V, VIII: +32.5 dBm (+/- 1 dBm) EGPRS Band II, III: +26.5 dBM (+/-1.5 dBm) EGPRS Band V, VIII: +27.5 dBM (+/-1.5 dBm)
	Maximum Power Consumption	LTE: 1,200 mA (peak); <900 mA (average) WCDMA: 1,100 mA (peak); <800 mA (average) EGPRS: 2,800 mA (peak); <700 mA (average)
	Power Consumption, Sleep Mode	3 mA
	Power Management	USB selective suspend, Integrated notebook wireless button
	Antenna Type	Dual high efficiency multi-band antennae with spatial diversity
	Form Factor	M.2, USB 2.0 interface
	Weight	6 g
	Dimensions (Length x Width x Thickness)	42 mm × 30 mm × 2.3 mm
	Voltage, Operating	3.135 V to 4.4 V (3.3 V +1.1V/-0.165V)
	Temperature, operating (from TIA/EIA/IS-98-D)	14° to 131° F (-10° to 55° C)
	Temperature, non- operating, 96 hours (from MIL-STD 202 Method 108)	-40° to 185° F (-40° to 85° C)
	Humidity, Non-operating	95% relative humidity for 48 hours @ 185° F (85° C) (non-condensing)
	LED Activity	LED Off - Radio Off; Solid LED On - Radio On



Technical Specifications

* 4G LTE not available on all products, in all regions and only available on products featuring Intel processors. WWAN use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors.

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Atheros 802.11 b/g/n (1x1)*

Wireless LAN Standards	IEEE 802.11b		
	IEEE 802.11g IEEE 802.11n		
Interoperability	Wi-Fi certified		
Frequency Band	2.4 GHz		
Data Rates	802.11b: 1, 2, 5.5, 11 Mbps		
Dala Kales	802.11g: 6, 9, 12, 18, 24, 36	5. 48. 54 Mbns	
		ta rates, ranging from 6 Mbps to 300 Mbps,	
	depending on the combinat	ion of Bandwidth, Modulation Coding Scheme, and ned in IEEE 802.11n specification	
Modulation	Direct Sequence Spread Spe DBPSK, DQPSK, CCK, OFDM,	ectrum BPSK, QPSK, 16-QAM, 64-QAM	
Security ¹		/EP, WPA, WPA2, hardware-accelerated AES, s EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPv2,	
Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.		
Media Access Protocol	CSMA/CA (Collision Avoidan	ce) with ACK	
Network Architecture	Ad-hoc (Peer to Peer)		
Models	Infrastructure (Access Point Required)		
Roaming	IEEE 802.11 compliant roaming between access points		
Output Power ²	13.5 dBm, nominal		
Power Consumption	Transmit: 2.0 W (max)		
	Receive: 1.6 W (max)		
	Associated to Access Point, Idle: 250 mW nominal Wireless Button Off: 100 mW nominal		
	Radio disabled: 75 mW nominal		
Power Management	ACPI compliant power management		
	802.11 compliant power sa	ving mode	
Receiver Sensitivity ³	72.2 Mbps: -70 dbm, 54 Mbps: -74 dBm, 11 Mbps: -88 dBm , 1 Mbps: -95 dBm		
Antenna Connections	High efficiency antenna with spatial diversity, mounted in the display enclosure		
Form Factor	PCI-Express Half-MiniCard 1.2		
Weight	0.013 lb (6 g)		
Dimensions	0.19 x 1.06 x 1.18 in (4.75 x 26.8 x 30 mm)		
Operating Voltage	3.3v +/- 9%		
Temperature	Operating	14° to 158° F (-10° to 70° C)	
	Non-operating	-40° to 176° F (-40° to 80° C)	



Technical Specifications

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	Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
	Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
	LED Activity	LED Off - Radio OFF; Solid	
	 Maximum output power Receiver sensitivity is m error rate of 10% for 802. 	may vary by country accord leasured at a packet error ra 11a/g (OFDM modulation).	supported security features. ling to local regulations. te of 8% for 802.11b (CKK modulation) and a packet wailability of public wireless access points limited.
Atheros 802.11b/g/n (1x1) and Bluetooth 4.0 Combo*	Wireless LAN Standards	IEEE 802.11b IEEE 802.11g IEEE 802.11n	
	Interoperability	Wi-Fi certified	
	Frequency Band	2.402 - 2.482 GHz	
	Data Rates	802.11b: 1, 2, 5.5, 11 Mbp 802.11g: 6, 9, 12, 18, 24, 3 802.11n: card will support Short and long guard inter	36, 48, 54 Mbps : rates for NSS=1 for RX and TX for 20 MHz channels.
	Modulation	Direct Sequence Spread Sp BPSK, QPSK, CCK, 16-QAM	
	Security ¹	EAP-PEAPv2, EAP-FAST, E Support for using both ma same profile must be able login Support the use of Window for an auto-logon to Wind (http://support.microsoft. Must have Windows Single WLAN as their primary dor association and authentica domain authentication is a Support for use of the UI c privileges Client service / profile mar Protected Setup specificat Any credentials saved in a be re-used by any other us	b to and including CCXv5 EAP types: EAP-TLS, EAP-PEAPv0, EAP-PEAPv1, AP-SIM inchine and user credentials in a single profile. The to be used both before user login and after user ws Domain credentials IP provider shall have support ows using a PLC and LEAP via the IP provider UI com/default.aspx/kb/315231). e Sign On support so that customers can use the main network. With regard to SSO, network ation must occur and be successful before Windows attempted lient in a user account with limited local security mager must support the WiFi Alliance's WiFi cion. profile must be done securely such that they cannot
	Network Architecture	Ad-hoc (Peer to Peer)	at Deguized)
	Models	Infrastructure (Access Poin	•
	Roaming	-	ming between access points
	Output Power ²	13.5dBm , minimum	



Technical Specifications

Power Consumption	Transmit: 2.0 W (max) Receive: 1.6 W (max) Associated to Access Point, Idle: 250 mW nominal		
	Wireless Button Off: 100 mW nominal Radio disabled: 75 mW nominal		
Power Management	ACPI and PCI Express comp 802.11 compliant power s	oliant power management	
Receiver Sensitivity ³	802.11b:-95 dBm (1 Mbps) (11 Mbps)), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps), -88 dBm	
	802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps)		
	802.11n:-70dBm (72.2 Mb	ps)	
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure		
Form Factor	PCI-Express Half-MiniCard		
Dimensions	0.19 x 1.06 x 1.18 in (4.75	x 26.8 x 30 mm)	
Operating Voltage	3.3v +/- 10%		
Temperature	Operating Non-operating	14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)	
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)	
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)	
LED Activity	LED Off - Radio OFF; Solid LED On - RadioON		
 Check latest software/driver release for updates on supported security features. Maximum output power may vary by country according to local regulations. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation). 			
Bluetooth Specification	V4.0 High Speed, V2.1+EDR, backwards compatible with V1.1, 1.2 and 2.0		
Number of Available Channels	79 (1 MHz) available channels		
Data Rates and	3 Mbps data rate; through	put up to 2.17 Mbps	
Throughput	Synchronous Connection C	riented links up to 3, 64 kbps, voice channels	
	Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric or		

1306.9 kbps symmetric **Transmit Power** -6 dBm to 4 dBm (Bluetooth Class II)

Receiver Sensitivity Better than -80 dBM at 0.1 % raw bit error rate

Power Consumption Peak (Tx) 330 mW

> Peak (Rx) 230 mW Sleep <17 mW

Antenna Internally integrated within module Up 33 ft (10 m)



Range

Technical Specifications

Electrical Interface	USB 2.0 compliant
	Microsoft Windows Plug and Play compliant
Bluetooth Software	Broadcom Bluetooth for Windows
Supported	Microsoft Windows Bluetooth Software
Link Topology	Point to Point, Multipoint Pico Nets up to 7 slaves
Security	Full support of Bluetooth Security Provisions
Power Management	Microsoft Windows ACPI, and USB Bus Support
	Self configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff
Certifications	All necessary regulatory approvals for supported countries, including:
	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
	ETS 300 328, ETS 300 826
	Low Voltage Directive IEC950
	UL, CSA, and CE Mark
Bluetooth Profiles	Generic Access Profile (GAP)
Supported	Service Discovery Application Profile (SDAP)
	Serial Port Profile (SPP) Dial_Up Networking Profile (DUN)
	Generic Object Exchange Profile (GOEP)
	Object Push Profile (OPP)
	File Transfer Profile (FTP)
	Synchronization Profile (SYNC)
	Hard Copy Cable Replacement (HCRP)
	Personal Area Networking Profile (PAN)
	Human Interface Device Profile (HID)
	Generic Audio/Video Distribution Profile (GAVDP)
	Advanced Audio/Video Distribution Profile (A2DP) FAX Profile (FAX)
	Basic Imaging Profile (BIP)
	Headset Profile (HSP)
	Hands Free Profile (HFP)
	Basic Printing Profile (BPP)
	VDP (Video Distribution Profile)
	AVRCP (Audio Video Remote Control Profile)
* 14/2001	distance convice a suited. As significant sublication concerns the limited

* Wireless access point and internet service required. Availability of public wireless access points limited.

Broadcom 802.11 a/b/g/n (2x2) with Bluetooth® v4.0 combo*, **	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n
	Interoperability	Wi-Fi certified
	Frequency Band	802.11b/g/n
		• 2.402 - 2.482 GHz

802.11a/n


Technical Specifications	
Data Rates	 4.9 - 4.95 GHz (Japan) 5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz 2.402 - 2.482 GHz 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	802.11n: card will support rates for NSS=1 and NSS=2 for RX and TX for 20 and 40 MHz channels. Short and long guard interval shall be supported.
Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM
Security ¹	 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification IEEE 802.11i Cisco Certified Extensions, all versions through V5 WAPI
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power ²	 2.4G: +13.5dBm minimum 5G: +12dBm minimum Maximum output power must be able to achieve modular regulatory certification with notebooks that have antennas >20cm from the user and peak gain of +3dBi at 2.4GHz and +4dBi at 5GHz
Power Consumption	Transmit: 2.0 W (max) Receive: 1.6 W (max) Idle mode (PSP): 250 mW (WLAN Associated) Idle mode: 100 mW (WLAN unassociated) Radio disabled: 75 mW
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity ³	802.11b:-95 dBm (1 Mbps), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps), -88 dBm (11 Mbps)
	802.11a/g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps)
	802.11n:-69 dBm (72.2 Mbps), -66 dBm (300 Mbps)



Technical Specifications

Antenna type	enclosure Two embedded dual b	na with spatial diversity, mounted in the display and 2.4/5 GHz antennas are provided to the card to ommunications and Bluetooth communications
Form Factor	PCI-Express Half-MiniCard	
Dimensions	0.19 x 1.06 x 1.18 in (4.75 x 26.8 x 30 mm)	
Weight	3.3g	
Operating Voltage	3.3v +/- 9%	
Temperature	Operating Non-operating	14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
LED Activity	LED Off - Radio OFF; Solid LED On - Radio ON	

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Bluetooth Specification

V4.0 High Speed, V2.1+EDR, backwards compatible with V1.1, 1.2 and 2.0

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Number of Available Channels	79 (1 MHz) available channels
Data Rates and Throughput	3 Mbps data rate; throughput up to 2.17 Mbps
	Synchronous Connection Oriented links up to 3, 64 kbps, voice channels
	Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric or 1306.9 kbps symmetric
Transmit Power	-6 dBm to 4 dBm (Bluetooth Class II)
Receiver Sensitivity	Better than -80 dBM at 0.1 % raw bit error rate
Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Sleep <17 mW
Antenna	Internally integrated within module
Range	Up to 33 ft (10 m)
Electrical Interface	USB 2.0 compliant Microsoft Windows Plug and Play compliant
Bluetooth Software Supported	Broadcom Bluetooth for Windows Microsoft Windows Bluetooth Software
Link Topology	Point to Point, Multipoint Pico Nets up to 7 slaves
Security	Full support of Bluetooth Security Provisions



Technical Specifications

Power Management	Microsoft Windows ACPI, and USB Bus Support Self configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff
Certifications	All necessary regulatory approvals for supported countries, including: FCC (47 CFR) Part 15C, Section 15.247 & 15.249 ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark
Bluetooth Profiles Supported	Generic Access Profile (GAP) Service Discovery Application Profile (SDAP) Serial Port Profile (SPP) Dial_Up Networking Profile (DUN) Generic Object Exchange Profile (GOEP) Object Push Profile (OPP) File Transfer Profile (FTP) Synchronization Profile (SYNC) Hard Copy Cable Replacement (HCRP) Personal Area Networking Profile (PAN) Human Interface Device Profile (HID) Generic Audio/Video Distribution Profile (GAVDP) Advanced Audio/Video Distribution Profile (A2DP) FAX Profile (FAX) Basic Imaging Profile (BIP) Headset Profile (HSP) Hands Free Profile (HFP) Basic Printing Profile (BPP) VDP (Video Distribution Profile)

* Wireless access point and internet service required. Availability of public wireless access points limited. ** Bluetooth sold separately or as an optional feature.

Intel Dual Band Wireless- N 7260 802.11 a/b/g/n (2x2) WiFi + Bluetooth 4.0 Combo Adaptor*, **		IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n	
	Interoperability	•	ns Program compliant with Microsoft Windows 7, ails at: http://www.hp.com/go/notebooks/WLAN)
	Frequency Band	802.11b/g/n	2.402 - 2.482 GHz
		802.11a/n	4.9 - 4.95 GHz (Japan) 5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz
	Antenna Structure	2 transmit; 2 receive (2x2)	

Technical Specifications	
Data Rates	802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: card will support rates for NSS=1 and NSS=2 for RX and TX for 20 and 40 MHz channels. Short and long guard interval shall be supported.
Modulation	Direct Sequence Spread Spectrum CCK, BPSK, QPSK, 16-QAM, 64-QAM
Security ¹	 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification IEEE 802.11i Cisco Certified Extensions, all versions through V5 WAPI
Sub-channel	s Multinational support with frequency bands and channels compliant to local regulations.
Network Arc Models	nitecture Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between band Access Points
Output Powe	r ² • 2.4G: +13.5dBm minimum • 5G: +12dBm minimum
Power Consu	mption Transmit: 2.0 Watts Receive: 1.6 Watts Idle mode ³ : 250 mW (WLAN Associated) Idle mode: 100 mW (WLAN unassociated) Radio off: 75 mW
Power Manag	ement ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sen	sitivity ⁴ 802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps)
	802.11b:-95 dBm (1 Mbps), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps), -88 dBm (11 Mbps)
	802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps)
	802.11n:-69 dBm (150 Mbps), -66 dBm (300 Mbps)
Antenna Con	
Form Factor	PCI-Express Half-MiniCard
Dimensions	0.12 x 1.06 x 1.18 in (3.1 x 26.8 x 30.0 mm)
Weight	TBD
Operating Vo	



Technical Specifications

Temperature	Operating Non-operating	14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
LED Activity	LED Off - Radio OFF; Solio	d LED On - Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. In Power Save Polling mode and on battery power.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

5. WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista.

HP Integrated Module with Bluetooth 4.0+EDR Wireless Technology

Bluetooth Specification	4.0+EDR Compliant
Dimensions	1.18 x 0.26 x 0.13 in (30 x 6.5 x 3.25 mm)
Frequency Band	2402 to 2480 MHz
Number of Available Channels	79 (1 MHz) available channels
Data Rates and	3 Mbps data rate; throughput up to 2.17 Mbps
Throughput	Synchronous Connection Oriented links up to 3, 64 kbps, voice channels
	Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric or 1306.9 kbps symmetric
Transmit Power	-1.5 dBm to 4 dBm (Bluetooth Class II)
Receiver Sensitivity	Better than -20 dBM at 0.1 % raw bit error rate
Power Consumption	Peak (Tx) 264 mW Peak (Rx) 231 mW Sleep <1 mW
Antenna	Internally integrated within module
Range	Up to 33 ft (10 m)
Electrical Interface	USB 2.0 compliant
	Microsoft Windows Plug and Play compliant
Bluetooth Software	Broadcom Bluetooth for Windows
Supported	Microsoft Windows Bluetooth Software
Link Topology	Point to Point, Multipoint Pico Nets up to 7 slaves
Security	Full support of Bluetooth Security Provisions
Power Management	Microsoft Windows ACPI, and USB Bus Support
	Self configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff



	Certifications	All necessary regulatory approvals for supported countries, including:
		FCC (47 CFR) Part 15C, Section 15.247 & 15.249
		ETS 300 328, ETS 300 826
		Low Voltage Directive IEC950
		UL, CSA, and CE Mark
	Bluetooth Profiles Supported	Serial Port Profile (SPP) ¹ Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) ^{1,2} Generic Object Exchange Profile (GOEP) ^{1,2} Object Push Profile (OPP) ^{1,2} File Transfer Profile (FTP) Synchronization Profile (SYNC) Hard Copy Cable Replacement (HCRP) ^{1,2} Personal Area Networking Profile (PAN) ^{1,2} Human Interface Device Profile (HID) ^{1,2} FAX Profile (FAX) Basic Imaging Profile (BIP) ² Headset Profile (HSP) Hands Free Profile (HFP)
		Advanced Audio Distribution Profile (A2DP)
	2. indicates the profile is particular to the profile is particula	upported by Microsoft Windows XP SP2 art of Windows Vista I internet service required. Availability of public wireless access points limited. Iy or as an optional feature.
Intel Dual Band Wireless- AC 7260 802.11 ac (2x2) WiFi + BT 4.0 combo Adapter*, **	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac
	Interoperability	Wi-Fi certified
	Frequency Band	802.11b/g/n
		• 2.402 - 2.482 GHz
		802.11a/n
		 4.9 - 4.95 GHz (Japan) 5.15 - 5.25 GHz 5.25 - 5.35 GHz\ 5.47 - 5.725 GHz 5.825 - 5.850 GHz 2.402 - 2.482 GHz
	Data Rates	 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)



Modulation Direct Sequence Spread Spectrum BPSK, OPSK, CCK, 16-QAM, 64-QAM, 256-QAM Security ¹ IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1 x authentication WPA, WPA2: 802.1 x, WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification IEEE 802.111 Cisco Certified Extensions, all versions through CCX4 and CCX Lite WAP Network Architecture Models Infrastructure (Access Point Required) Roaming IEEE 802.11 compliant roaming between access points Output Power² 2.4.6: +13.5dBm minimum SG: +12dBm minimum Maximum output power must be able to achieve modular regulatory certification with notebooks that have antennas > 20cm from the user and peak gain of +3dBi at 2.4GHz and +4dBi at 5GHz Power Consumption Transmit: 2.0 W (max) Receive: 1.6 W (max) Idle mode: 100 mW (WLAN Associated) Idle mode (PSP): 250 mW (WLAN Associated) Idle mode: 110 omW (WLAN unassociated) Radio disabled: 75 mW Power Sensitivity³ 802.11n:-69 dBm (72.2 Mbps), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps), -86 dBm (11 Mbps) 802.11n:-69 dBm (72.2 Mbps), -95 dBm (36 Mbps), -74 dBm (48 Mbps), -74 dBm (5			
only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certified Extensions, all versions through CCX4 and CCX Lite WPA2 certified Extensions, all versions through CCX4 and CCX Lite Network Architecture Ad-hoc (Peer to Peer) Infrastructure (Access Point Required) Roaming IEEE 802.11 compliant roaming between access points Output Power ² • 2.4G: +13.5dBm minimum • SG: +12dBm minimum • SG: +12dBm minimum • Maximum output power must be able to achieve modular regulatory certification with notebooks that have antennas >20cm from the user and peak gain of +3dBi at 2.4GHz and +4dBi at 5GHz Power Consumption Transmit: 2.0 W (max) Receive: 1.6 W (max) Idle mode (PSP): 250 mW (WLAN Associated) Idle mode (PSP): 250 mW (WLAN unassociated) Radio disabled: 75 mW Power Management ACPI and PCI Express compliant power management 802.11 compliant power saving mode Receiver Sensitivity ³ 802.11b:-95 dBm (1 Mbps), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps), -88 dBm (11 Mbps) 802.111:-69 dBm (72.2 Mbps), -66 dBm (300 Mbps) Antenna type High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIM0 communications and Bluetooth communications Form Factor PCI-Express Half-MiniCard	Modulation	· · ·	•
Models Infrastructure (Access Point Required) Roaming IEEE 802.11 compliant roaming between access points Output Power ² : 2.4G: +13.5dBm minimum SG: +12dBm minimum : SG: +12dBm minimum Maximum output power must be able to achieve modular regulatory certification with notebooks that have antennas >20cm from the user and peak gain of +3dBi at 2.4GHz and +4dBi at 5GHz Power Consumption Transmit: 2.0 W (max) Receive: 1.6 W (max) Receive: 1.6 W (max) Redio disabled: 75 mW Power Management ACPI and PCI Express compliant power management 802.11 compliant power saving mode Receiver Sensitivity ³ 802.11a/g:-90 dBm (6 Mbps), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps), -88 dBm (11 Mbps) 802.11a/g:-90 dBm (6 Mbps), -79 dBm (36 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps) Antenna type 802.11n:-69 dBm (72.2 Mbps), -66 dBm (300 Mbps) High efficiency antenna with spatial diversity, mounted in the display enclosure 119 x 1.06 x 1.18 in (4.75 x 26.8 x 30 mm) Form Factor PCI-Express Half-MiniCard Tomes and Plate to 158° F (-10° to 70° C) Non-operating Weight 3.1g 3.1g Operating 14° to 158° F (-10° to 70° C) Non-operating -40° to 176° F (-40° to 80° C) Humidity Operating 14° to 158° F (-10° to 70° C) Non-operati	Security ¹	 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification IEEE 802.11i Cisco Certified Extensions, all versions through CCX4 and CCX Lite 	
Output Power2• 2.4G: +13.5dBm minimum • 5G: +12dBm minimum • Maximum output power must be able to achieve modular regulatory certification with notebooks that have antennas >20cm from the user and peak gain of +3dBi at 2.4GHz and +4dBi at 5GHzPower ConsumptionTransmit: 2.0 W (max) Receive: 1.6 W (max) Idle mode (PSP): 250 mW (WLAN Associated) Idle mode (PSP): 250 mW (WLAN unassociated) Radio disabled: 75 mWPower ManagementACPI and PCI Express compliant power management 802.11 compliant power saving modeReceiver Sensitivity3802.11b:-95 dBm (1 Mbps), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps), -88 dBm (11 Mbps)Antenna type802.11n:-69 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (22 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps)Form FactorPCI-Express Half-MiniCard Unersistand dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communicationsForm FactorPCI-Express Half-MiniCard DimensionsOperating Voltage3.3v +/- 9%Temperature0.perating14° to 158° F (-10° to 70° C) Non-operating-40° to 176° F (-40° to 80° C)HumidityOperatingOperating14° to 158° F (-10° to 70° C) Non-colensing)			pint Required)
 5G: +12dBm minimum Maximum output power must be able to achieve modular regulatory certification with notebooks that have antennas >20cm from the user and peak gain of +3dBi at 2.4GHz and +4dBi at 5GHz Power Consumption Transmit: 2.0 W (max) Receive: 1.6 W (max) Idle mode (PSP): 250 mW (WLAN Associated) Idle mode (PSP): 250 mW (WLAN unassociated) Radio disabled: 75 mW Power Management ACPI and PCI Express compliant power management 802.11 compliant power saving mode Receiver Sensitivity³ 802.11b:-95 dBm (1 Mbps), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps), -88 dBm (11 Mbps) 802.11a/g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps) 802.11n:-69 dBm (72.2 Mbps), -66 dBm (300 Mbps) Antenna type High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications Form Factor PCI-Express Half-MiniCard Dimensions 0.19 x 1.06 x 1.18 in (4.75 x 26.8 x 30 mm) Weight 3.1g Operating 14° to 158° F (-10° to 70° C) Non-operating -40° to 176° F (-40° to 80° C) Humidity Operating 0perating 0perating<th>Roaming</th><th>IEEE 802.11 compliant ro</th><th>paming between access points</th>	Roaming	IEEE 802.11 compliant ro	paming between access points
Receive: 1.6 W (max) Idle mode (PSP): 250 mW (WLAN Associated) Idle mode: 100 mW (WLAN unassociated) Radio disabled: 75 mWPower ManagementACPI and PCI Express compliant power management 802.11 compliant power saving modeReceiver Sensitivity3802.11b:-95 dBm (1 Mbps), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps), -88 dBm (11 Mbps)802.11a/g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps)Antenna type802.11n:-69 dBm (72.2 Mbps), -66 dBm (300 Mbps) High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIM0 communications and Bluetooth communicationsForm FactorPCI-Express Half-MiniCard Dimensions0.19 x 1.06 x 1.18 in (4.75 x 26.8 x 30 mm)Weight3.1g14° to 158° F (-10° to 70° C) Non-operating -40° to 176° F (-40° to 80° C)HumidityOperating14° to 90% (non-condensing)	Output Power ²	 2.4G: +13.5dBm minimum 5G: +12dBm minimum Maximum output power must be able to achieve modular regulatory certification with notebooks that have antennas >20cm from the user 	
802.11 compliant power saving modeReceiver Sensitivity3802.11b:-95 dBm (1 Mbps), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps), -88 dBm (11 Mbps)802.11a/g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps)802.11n:-69 dBm (72.2 Mbps), -66 dBm (300 Mbps)Antenna typeHigh efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communicationsForm FactorPCI-Express Half-MiniCardDimensions0.19 x 1.06 x 1.18 in (4.75 x 26.8 x 30 mm)Weight3.1gOperating Voltage3.3v +/- 9%TemperatureOperating14° to 158° F (-10° to 70° C) Non-operatingHumidityOperating10% to 90% (non-condensing)	Power Consumption	Receive: 1.6 W (max) Idle mode (PSP): 250 mW (WLAN Associated) Idle mode: 100 mW (WLAN unassociated)	
 (11 Mbps) 802.11a/g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps) 802.11n:-69 dBm (72.2 Mbps), -66 dBm (300 Mbps) 80.1111, 100 (12.4 Mbps) 8	Power Management		
(18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps)Antenna type802.11n:-69 dBm (72.2 Mbps), -66 dBm (300 Mbps)High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communicationsForm FactorPCI-Express Half-MiniCardDimensions0.19 x 1.06 x 1.18 in (4.75 x 26.8 x 30 mm)Weight3.1gOperating Voltage3.3v +/- 9%TemperatureOperating -40° to 176° F (-40° to 80° C)HumidityOperating	Receiver Sensitivity ³	•	os), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps), -88 dBm
Antenna typeHigh efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communicationsForm FactorPCI-Express Half-MiniCardDimensions0.19 x 1.06 x 1.18 in (4.75 x 26.8 x 30 mm)Weight3.1gOperating Voltage3.3v +/- 9%TemperatureOperating Non-operating Operating14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)HumidityOperating10% to 90% (non-condensing)		(18 Mbps), -82 dBm (24 I	
enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communicationsForm FactorPCI-Express Half-MiniCardDimensions0.19 x 1.06 x 1.18 in (4.75 x 26.8 x 30 mm)Weight3.1gOperating Voltage3.3v +/- 9%TemperatureOperating Non-operating14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)HumidityOperating10% to 90% (non-condensing)		802.11n:-69 dBm (72.2 M	Mbps), -66 dBm (300 Mbps)
Dimensions 0.19 x 1.06 x 1.18 in (4.75 x 26.8 x 30 mm) Weight 3.1g Operating Voltage 3.3v +/- 9% Temperature Operating number of the second	Antenna type	enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to	
Weight3.1gOperating Voltage3.3v +/- 9%TemperatureOperating Non-operating14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)HumidityOperating10% to 90% (non-condensing)	Form Factor	PCI-Express Half-MiniCard	
Operating Voltage 3.3v +/- 9% Temperature Operating Non-operating 14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C) Humidity Operating 10% to 90% (non-condensing)	Dimensions	0.19 x 1.06 x 1.18 in (4.75 x 26.8 x 30 mm)	
Temperature Operating Non-operating 14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C) Humidity Operating 10% to 90% (non-condensing)	Weight	3.1g	
Non-operating-40° to 176° F (-40° to 80° C)HumidityOperating10% to 90% (non-condensing)	Operating Voltage	3.3v +/- 9%	
	Temperature		
	Humidity		-



Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
LED Activity	LED Off - Radio OFF; Solid L	
 Check latest software/d Maximum output power Receiver sensitivity is merror rate of 10% for 802.1 	river release for updates on s may vary by country accordi easured at a packet error rat	supported security features.
Bluetooth Specification		
	R, backwards compatible with	
Number of Available Channels	79 (1 MHz) available chann	els
Data Rates and Throughput	3 Mbps data rate; throughp	put up to 2.17 Mbps
	Synchronous Connection O	riented links up to 3, 64 kbps, voice channels
	Asynchronous Connection 1306.9 kbps symmetric	Less links 2178.1 kbps/177.1 kbps asymmetric or
Transmit Power	-6 dBm to 4 dBm (Bluetoot	h Class II)
Receiver Sensitivity	Better than -80 dBM at 0.1	% raw bit error rate
Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Sleep <17 mW	
Antenna	Internally integrated within module	
Range	Up to 33 ft (10 m)	
Electrical Interface	USB 2.0 compliant Microsoft Windows Plug an	d Play compliant
Bluetooth Software Supported	Broadcom Bluetooth for W Microsoft Windows Bluetoo	
Link Topology	Point to Point, Multipoint P	ico Nets up to 7 slaves
Security	Full support of Bluetooth S	ecurity Provisions
Power Management	Microsoft Windows ACPI, an Self-configurable to optimi including Standby, Hold, Pa	ize power conservation in all operating modes,
Certifications	All necessary regulatory ap FCC (47 CFR) Part 15C, Sect ETS 300 328, ETS 300 826 Low Voltage Directive IEC9 UL, CSA, and CE Mark	
Bluetooth Profiles Supported	Generic Access Profile (GAP Service Discovery Applicati Serial Port Profile (SPP) Dial_Up Networking Profile Generic Object Exchange Pro Object Push Profile (OPP) File Transfer Profile (FTP) Synchronization Profile (SY	on Profile (SDAP) e (DUN) rofile (GOEP)



Hard Copy Cable Replacement (HCRP) Personal Area Networking Profile (PAN) Human Interface Device Profile (HID) Generic Audio/Video Distribution Profile (GAVDP) Advanced Audio/Video Distribution Profile (A2DP) FAX Profile (FAX) Basic Imaging Profile (BIP) Headset Profile (HSP) Hands Free Profile (HSP) Basic Printing Profile (BPP) VDP (Video Distribution Profile) AVRCP (Audio Video Remote Control Profile)

* Wireless access point and internet service required. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices

** Bluetooth sold separately or as an optional feature.

Intel Centrino® Advanced- N 6205 802.11a/b/g/n (2x2)*	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n
	Interoperability	Wi-Fi certified Cisco Compatible Extensions Program compliant with Microsoft Windows 7, Windows Vista and XP (details at: http://www.hp.com/go/notebooks/WLAN)
	Frequency Band	2.4 GHz and 5GHz
	Antenna Structure	2 transmit; 2 receive (2x2)
	Data Rates	802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: 66 possible data rates, ranging from 6 Mbps to 300 Mbps, depending on the combination of Bandwidth, Modulation Coding Scheme, and Guard Interval used, as defined in IEEE 802.11n specification
	Modulation	Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM
	Security ¹	Authentication: WPA and WPA2, 802.1x (EAP_TLS, TTLS, PEAP, LEAP, EAP- FAST)
		Authentication Protocols: PAP, CHAP, TLS, GTC, MS-CHAP, MS-CHAPv2
		Encryption: 64 and 128-bit WEP, AES-CCMP, CKIP, TKIP
		Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program Version 4) with Microsoft Windows Vista and XP only.
	Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.
	Media Access Protocol	CSMA/CA (Collision Avoidance) with ACK



HP ProBook 640 G1 Notebook PC HP ProBook 650 G1Notebook PC

Technical Specifications

Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)			
Roaming	IEEE 802.11 compliant roa	ming between 2.4GHz band Access Points		
Output Power (for CCK an OFDM) ²	d 17 dBm max			
Power Consumption	Transmit: 2.3 Watts (max, with two spatial streams) Receive: 1 Watt (max with two spatial streams) Idle mode ³ : 35 mW (average) Radio off: 20 mW (max)			
Power Management	ACPI compliant power management 802.11 compliant power saving mode			
Receiver Sensitivity ⁴	54 Mbps: -76 dBm, 6 Mbps: -92 dBm			
Antenna Connections	2 U.FL type connectors, 50 ohm nominal impedance			
Form Factor	PCI-Express Half-MiniCard			
Weight	0.0075 lb (3.4 g)			
Dimensions	0.12 x 1.06 x 1.18 in (3.1 x	0.12 x 1.06 x 1.18 in (3.1 x 26.8 x 30.0 mm)		
Operating Voltage	3.3V +/- 9%	3.3V +/- 9%		
Temperature	Operating Non-operating	32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C)		
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 90% (non-condensing)		
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)		
LED Activity	LED Off - Radio OFF; Solid LED On - Radio ON			

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. In Power Save Polling mode and on battery power.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

5. WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista. * Wireless access point and internet service required. Availability of public wireless access points limited.

Intel Centrino® Advanced- N 6235 802.11a/b/g/n and Bluetooth 4.0 Combo*, **		IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n
	Interoperability	Wi-Fi certified Cisco Compatible Extensions Program compliant with Microsoft Windows 7, Windows Vista and XP (details at: http://www.hp.com/go/notebooks/WLAN)
	Frequency Band	2.4 GHz and 5 GHz



Technical Specifications			
Data Rates	802.11n: 66 possible on the combination (
Modulation	Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM		
Security ¹	Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES 802.1x authentication types EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSC LEAP, EAP-FAST.		
	infrastructure produ	curity Features (proven compatibility with Cisco Aironet cts through the Cisco Compatible Extensions Program psoft Windows 7, Windows Vista and XP only.	
Sub-channels	Multinational suppor regulations.	rt with frequency bands and channels compliant to local	
Media Access Protocol	CSMA/CA (Collision A	voidance) with ACK	
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)		
Roaming	IEEE 802.11 compliant roaming between access points		
Output Power ²	13.5 dBm , nominal		
Power Consumption	Idle associated: 250 Idle unassociated: 10 Radio disabled: 75m Transmit: 2.0 W (max) Receive: 1.6 W (max)	DO mW W x)	
Power Management	ACPI compliant powe 802.11 compliant po	-	
Receiver Sensitivity ³	54 Mbps: -71 dBm, 1	1 Mbps: -85 dBm , 1 Mbps: -95 dBm	
Antenna Connections	High efficiency dual display enclosure	band antenna with spatial diversity, mounted in the	
Form Factor	PCI-Express Half-Mir	niCard 1.2	
Weight	0.013 lb (6 g)		
Dimensions	0.19 x 1.06 x 1.18 in	(4.75 x 26.8 x 30 mm)	
Operating Voltage	3.3v +/- 10%		
Temperature	Operating Non-operating	14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)	
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)	
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)	
Configuration Utility ⁴	Microsoft Windows X Choice of Configura	(P	

• Microsoft Windows XP Wireless Network Connection Manager

• Broadcom Wireless Configuration Utility (required for Cisco Compatible Extensions support)

Microsoft Windows Vista

- Microsoft Windows Vista Wireless Network Connection Manager
- Broadcom IHV extensions for Windows Vista available to support Cisco Compatible Extensions.

Microsoft Windows 7

- Microsoft Windows 7 Wireless Network Connection Manager
- Broadcom IHV extensions for Windows 7 available to support Cisco Compatible Extensions.

LED Activity

LED Off - Radio OFF; Solid LED On - Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

4. WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista.

Blueloolii 4.0 Wileless It	echnology
Bluetooth Specification	2.1+EDR, 3.0+HS, 4.0 Compliant
Dimensions	1.18 x 0.26 x 0.13 in (30 x 6.5 x 3.25 mm)
Frequency Band	2402 to 2480 MHz
Number of Available Channels	79 (1 MHz) available channels
Data Rates and	3 Mbps data rate; throughput up to 2.17 Mbps
Throughput	Synchronous Connection Oriented links up to 3, 64 kbps, voice channels
	Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric or 1306.9 kbps symmetric
Transmit Power	Max 4 dBm (Bluetooth Class II)
Receiver Sensitivity	Better than -80 dBM at 0.1 % raw bit error rate
Power Consumption	Average 230mW
	Sleep <1 mW
Antenna	Internally integrated within module
Range	Up 33 ft (10 m)
Electrical Interface	USB 2.0 compliant
	Microsoft Windows Plug and Play compliant
Bluetooth Software	Broadcom Bluetooth for Windows
Supported	Microsoft Windows Bluetooth Software
Link Topology	Point to Point, Multipoint Pico Nets up to 7 slaves
Security	Full support of Bluetooth Security Provisions





HP ProBook 640 G1 Notebook PC HP ProBook 650 G1Notebook PC

Technical Specifications

Power Management	Microsoft Windows ACPI,	and USB Bus Support		
	Self configurable to optimize power conservation in all operating modes,			
	including Standby, Hold, Park, and Sniff			
Certifications	All necessary regulatory a	approvals for supported countries, including:		
	FCC (47 CFR) Part 15C, Se	ction 15.247 & 15.249		
	ETS 300 328, ETS 300 82	6		
	Low Voltage Directive IEC	950		
	UL, CSA, and CE Mark			
Temperature	Operating	-4° to 158° F (-20° to 70° C)		
	Non-operating	-40° to 176° F (-40° to 80° C)		
Humidity	Operating	10% to 90%		
	Non-operating	5% to 95%		
Altitude	Operating	15,000 ft (4,572 m)		
	Non-operating	40,000 ft (12,192 m)		
Bluetooth Profiles	Serial Port Profile (SPP) ¹			
Supported	Service Discovery Applica	ton Profile (SDAP)		
	Dial-Up Networking (DUN) ^{1,2} Generic Object Exchange Profile (GOEP) ^{1,2}			
Object Push Profile (OPP) ^{1,2} File Transfer Profile (FTP)				
	Hard Copy Cable Replacement (HCRP) ^{1,2} Personal Area Networking Profile (PAN) ^{1,2} Human Interface Device Profile (HID) ^{1,2,3} FAX Profile (FAX)			
	Basic Imaging Profile (BIP) ²			
	Headset Profile (HSP)			
	Hands Free Profile (HFP)			
	Advanced Audio Distribut	ion Profile (A2DP)		
1. indicates the profile is	supported by Microsoft Winc	lows XP SP2		

2. indicates the profile is part of Windows Vista

* Wireless access point and internet service required. Availability of public wireless access points limited.

** Bluetooth sold separately or as an optional feature.

AUDIO/MULTIMEDIA - DTS SOUND+



Technical Specifications

Hardware	Implementation	IDT 92HD91
	Function Key Volume Controls	Volume up, volume down, and mute
	Full Duplex	Yes
	Microphone In	Stereo
	Headphone/Line Out	Stereo
	Integrated Microphone	Yes, dual digital microphone array when equipped with optional webcam
Audio Output Quality	Frequency Response	20 Hz - 20 kHz
	Signal to Noise Ratio	>85 dB
	Total Harmonic Distortio	n 0.01%
	Noise Floor	-110 dB
	Play/Record Sampling Rate(s)	8 kHz - 48kHz
	DAC	16, 20 or 24-bit
	ADC	16 or 20-bit
Integrated Stereo	Power Rating	2 Watts
Speakers	Impedance	4 Ohms

POWER

HP 90W Smart AC Adapter (discrete or UMA	Dimensions Weight	5.00 x 1.97 x 1.1 in (12.7 x 5.0 x 2.9 cm) 0.82 lb (370 g)		
configurations)	Input	100 to 240 VAC		
		Input Efficiency	87% min at 115 VAC	
		Input frequency range	47 to 63 Hz	
		Input AC current	1.5 A at 90 VAC, 0.75 A at 180 VAC PFC Version	
			2.4 A at 90 VAC, 1.2 A at 180 VAC NON PFC Version	
	Output	Output power	90W	
		DC output	19.0V	
		Hold-up time	5 msec at 115 VAC input	
		Output current limit	<11A, Over voltage protection- 29V max automatic shutdown	
	Connector	3 pin/grounded, mates with interchangeable cords		
	Environmental Design	Operating temperature	32° to 104° F (0° to 40° C)	
		Non-operating (storage) temperature	-4° to 149° F (-20° to 65° C)	
		Altitude	0 to 10,000 ft (0 to 3,048 m)	



Technical Specifications

	EMI and Safety Certifications	standards - IEC60950, EN6 C-UL-US, NORDICS, DENAN	20% to 80% 10% to 90% with LVD and EMC directives; Worldwide safety 50950, UL60950, Class1, SELV; Agency approvals - I, EN55022 Class B, FCC Class B, CISPR22 Class B, over 200,000 hours at 25°C ambient condition.	
HP 65W Smart AC Adapter	Dimensions	4.17 x 1.85 x 1.1 in (10.6 x	4.7 x 2.8 cm)	
(UMA configurations)	Weight	0.62 lb (280 g)		
	Input	100 to 240 VAC		
		Input Efficiency	87% min at 115 VAC	
		Input frequency range	47 to 63 Hz	
		Input AC current	1.7 A at 90 VAC, 0.85 A at 180 VAC	
	Output	Output power	65W	
		DC output	18.5V	
		Hold-up time	5 msec at 115 VAC input	
		Output current limit	<11A, Over voltage protection- 29V max automatic shutdown	
	Connector	3 pin/grounded, mates wit	h interchangeable cords	
	Environmental Design Operating temperature		32° to 104° F (0° to 40° C)	
		Non-operating (storage) temperature	-4° to 149° F (-20° to 65° C)	
		Altitude	0 to 10,000 ft (0 to 3,048 m)	
		Humidity	20% to 80%	
		Storage Humidity	10% to 90%	
	EMI and Safety Certifications	CE Mark - full compliance with LVD and EMC directives; Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; MTBF - over 200,000 hours at 25°C ambient condition.		



Technical Specifications	
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HP 9-cell (100 WHr)	Dimensions (H x W x L)	0.8 x 2.4 x 8.1in (2 x 6.6 x 2	0.5cm)
Lithium-Ion Primary	Weight (max)	1.1lb, (.488kg)	
battery	Cells/Type	Lithium-Ion	
	Energy	Voltage	11.25V
		Amp-hour capacity	8.85Ah
		Watt-hour capacity	100Wh
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)
		Operating (Discharging)	14° to 122° F(-10° to 50° C)
		Non-operating	-4° to 122° F (-20° to 50° C)
	Battery Re-Charge Time	System in OFF or Standby Mode	3.5 to 5 hours
		System ON	4 to 7 hours
	Fuel Gauge LED	No	
	Warranty	1 year	
	Compatible with optional Travel Battery	Yes	
HP 6-cell (55 WHr)	Dimensions (H x W x L)	0.8 x 1.8 x 8.0in (2.0 x 4.7 x	20.5cm)
Lithium-Ion Primary	Weight (max)	.70lb, (.313kg)	
battery	Cells/Type	Lithium-Ion	
	Energy	Voltage	10.8V
		Amp-hour capacity	5.1Ah
		Watt-hour capacity	55Wh
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)
		Operating (Discharging)	14° to 122° F(-10° to 50° C)
		Non-operating	-4° to 122° F (-20° to 50° C)
	Battery Re-Charge Time	System in OFF or Standby Mode	2.5 hours
		System ON	3 to 5 hours
	Fuel Gauge LED	No	
	Warranty	1 year	
	Compatible with optional Travel Battery	Yes	



Technical Specifications

HP 6-cell (55 WHr) Long	Dimensions (H x W x L)	0.8 x 1.8 x 8.0in (2.0 x 4.7 x 20.5cm)	
Life Primary Battery	Weight (max)	.72lb, (.323kg)	
	Cells/Type	Lithium-Ion	
	Energy	Voltage	10.8V
		Amp-hour capacity	5.1Ah
		Watt-hour capacity	55Wh
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)
		Operating (Discharging)	14° to 122° F(-10° to 50° C)
		Non-operating	-4° to 122° F (-20° to 50° C)
	Battery Re-Charge Time	System in OFF or Standby Mode	2.5 hours
		System ON	3 to 5 hours
	Fuel Gauge LED	No	
	Warranty	3 years*	
	Compatible with optional Travel Battery	Yes	
	* 3-year platform warranty	is required for a 3-year Long	g Life Battery warranty.
HP 3-cell (31 WHr)	Dimensions (H × W × L)	0.8 x 1.8 x 8.0in (2.0 x 4.7 x	20.5cm)
Lithium-Ion Primary	Weight (max)	0.47lb, (.210kg)	
battery	Cells/Type	Lithium-Ion	
	Energy	Voltage	11.1V
		Amp-hour capacity	2.8Ah
		Watt-hour capacity	31Wh
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)
		Operating (Discharging)	14° to 122° F(-10° to 50° C)
		Non-operating	-4° to 122° F (-20° to 50° C)
	Battery Re-Charge Time	System in OFF or Standby Mode	2.5 hours
		System ON	3 to 5 hours
	Fuel Gauge LED	No	
	Warranty	1 year	
	Compatible with optional Travel Battery	Yes	

ENVIRONMENTAL



Technical Specifications

Environmental Data

Eco-LabelThis product has received or is in the process of being certified to the following approvals and mayCertificationsbe labeled with one or more of these marks:& DeclarationsIT Eco. he he with

- IT ECO declaration
- US ENERGY STAR[®]
- EPEAT <Gold> registered in the United States. See http://www.epeat.net for registration status in your country.

HP ProBook 640 G1 Notebook PC

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".

Energy Consumption (in accordance with US ENERGY STAR® test method)

STAR [®] test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation	12.48 W	13.27 W	13.15 W
Sleep	0.86 W	1.02 W	0.85 W
Off	0.35 W	0.47 W	0.34 W

NOTE:

Energy efficiency data listed is for an ENERGY STAR[®] compliant product if offered within the model family. HP computers marked with the ENERGY STAR[®] Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR[®] specifications for computers. If a model family does not offer ENERGY STAR[®] compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows[®] operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation	43 BTU/hr	45 BTU/hr	45 BTU/hr
Sleep	3 BTU/hr	3 BTU/hr	3 BTU/hr
Off	1 BTU/hr	2 BTU/hr	1 BTU/hr

* Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.



Technical Specifications

Declared Noise Emissions			
(in accordance with ISO 7779 and ISO 9296)	Sound Power	Sound Pressure	
-	(LWAd, bels)	(LpAm, decibels)	
Typically Configured - Idle	3.4	27	
Fixed Disk - Random writes	3.4	27	
Batteries	This battery(s) in this product comply with EU Direct	IVE 2006/66/EC	
	Batteries used in the product do not contain: Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight		
	Battery size: CR2032 (coin cell) Battery type: Lithium Battery size: 6-cell high capacity Lithium-Ion batter Battery type:	y (optional 8 cell available)	
Additional Information	 This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC. 		
	 This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC. 		
	• This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).		
	 This product is in compliance with the IEEE 1680 (EPEAT) standard at the <gold> level, see www.epeat.net</gold> 		
	 Plastics parts weighing over 25 grams used in ISO1043. 	n the product are marked per ISO11469 and	
	 This product contains 5% post-consumer rec This product is 97.3% recycle-able when prop 		
	Packaging Materials		
	• External:		
	 PAPER/Corrugated 482.6 g 		
	Internal: O DI ACTIC (EDE (Expanded Deluctbulene)		
	 PLASTIC/EPE (Expanded Polyethylene PLASTIC/Polyethylene low density 30. 		
	 The PAPER/Corrugated packaging material is 	-	
	• The PLASTIC/EPE (Expanded Polyethylene) p	ackaging materials contains at least 50%	
	recycled content.	ging materials contains at least 50% recycled	
	content.		



Technical Specifications

HP ProBook 650 G1 Notebook PC

System C	onfiguration
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Energy Consumption

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".

(in accordance with US ENERGY	,		
STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation	13.57 W	13.7 W	12.9 W
Sleep	0.88 W	1.02 W	0.87 W
Off	0.36 W	0.47 W	0.35 W

NOTE:

Energy efficiency data listed is for an ENERGY STAR[®] compliant product if offered within the model family. HP computers marked with the ENERGY STAR[®] Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR[®] specifications for computers. If a model family does not offer ENERGY STAR[®] compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows[®] operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation	46 BTU/hr	47 BTU/hr	44 BTU/hr
Sleep	3 BTU/hr	3 BTU/hr	3 BTU/hr
Off	1 BTU/hr	2 BTU/hr	1 BTU/hr
	* Heat dissipation is calculated ba for one hour.	ased on the measured watts, assur	ning the service level is attained
Declared Noise Emissions			

(in accordance with ISO 7779 and ISO 9296)	Sound Power (LWAd, bels)	Sound Pressure (LpAm, decibels)
Typically Configured - Idle	3.6	29
Fixed Disk - Random writes	3.7	30
Batteries	ries This battery(s) in this product comply with EU Directive 2006/66/EC	
	Batteries used in the product do not contain:	

Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell) Battery type: Lithium Battery size: 6-cell high capacity Lithium-Ion battery (optional 8 cell available) Battery type:

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive -2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the <gold> level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and



Technical Specifications

IS01043.

- This product contains 5% post-consumer recycled plastic (by wt.)
- This product is 97.3% recycle-able when properly disposed of at end of life.

Packaging Materials

- External:
 - PAPER/Corrugated 482.6 g
- Internal:
 - O PLASTIC/EPE (Expanded Polyethylene) 28 g
 - PLASTIC/Polyethylene low density 30.4 g
- The PAPER/Corrugated packaging material is made from 70 % recycled content.
- The PLASTIC/EPE (Expanded Polyethylene) packaging materials contains at least 50% recycled content.
- The PLASTIC/Polyethylene low density packaging materials contains at least 50% recycled content.

ALL MODELS

MATERIAL USAGE

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at: http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

PACKAGING USAGE

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.



Technical Specifications

- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

END-OF-LIFE MANAGEMENT AND RECYCLING

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

HEWLETT-PACKARD CORPORATE ENVIRONMENTAL INFORMATION

For more information about HP's commitment to the environment:

Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_ISO_14K_Certificate.pdf and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

Country of Origin

China



Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part #
Cases	HP Professional Series Carrying Case (up to 15.6")	H4J90AA
	HP Professional Slim Top Load Case (up to 17.3")	H4J91AA
	HP Essential Top Load Case (up to 15.6")	H2W17AA#xxx
	HP Business Nylon Case	H5M92AA
	HP Business Backpack (up to 17.3")	H5M90AA
	HP Business 4 Wheel Roller Case	Н5М9ЗАА
Docking	HP Adjustable Dual Monitor Stand	AW664AA#xxx
	HP Adjustable Display Stand	AW663AA#xxx
	HP Display and Notebook Stand	AW662AA#xxx
	HP 90W Docking Station	A7E32AA#xxx
	HP 120W Advd Docking Station	A7E36AA#xxx
Input/Output	HP Comfort Grip Wireless Mouse	H2L63AA
	HP 3-Button USB Laser Mouse	H4B81AA
	HP USB Optical Travel mouse	RH304AA
Adapters	HP 65W Slim Adapter	AX727AA#XXX
	90W Smart AC Adapter	ED495AA#xxx
	90W Slim Adapter	BT796AA#xxx
	HP 65W Smart AC Adapter	H6Y89AA
	HP 90W Smart AC Adapter	H6Y90AA
	HP 65W Slim AC Adapter	H6Y82AA
	HP 90W Slim AC Adapter	H6Y83AA
Batteries	HP CA06XL Notebook Battery 6-cell 55 WHr	TBD
	HP CA09 Notebook Battery 9-cell 100 WHr	TBD
Security	HP Docking Station Cable Lock	AU656AA#XXX
	HP Notebook Combo Lock	AY475AA#XXX
	HP UltraSlim Keyed Cable Lock	H4D73AA
Storage - External Storage	HP Mobile USB DVDRW	A2U57AA
Health and Education	HP 20-Notebook Managed Charging Cart	QL489AA#xxx
	HP 30-Notebook Managed Charging Cart	QL490AA



Options and Accessories (sold separately and availability may vary by country)

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